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SX8674/SX8675/SX8676

Haptics Enabled Multitouch 4/5-Wire
Resistive Touchscreen Controller with Proximity Sensing

ADVANCED COMMUNICATIONS & SENSING

GENERAL DESCRIPTION

The SX8674, SX8675 and SX8676 belong to a family of high performance haptics enabled multitouch 4/5-wire resistive touch screen controller with proximity detection, optimized for hand held applications such as mobile phones, portable music players, game machines, point-of-sales terminal and other consumer and industrial applications. They feature a wide input supply range from 2.3V to 3.6V.

The controller computes touch screen X-Y coordinates and touch pressure with a precision, low power 12-bit analog-digital converter. On-chip data averaging processing algorithms can be activated to reduce host activity and suppress system noise. The processing core features low power modes which intelligently minimize current in operation as well as in automatic shut-down.

Multitouch feature enables detection of 2 fingers on the touchscreen and several gestures like rotation and pinch/stretch.

A capacitive proximity detection circuit has been integrated into the SX8674 and SX8676 to enable host controlled power management for battery applications. Proximity detection above 5 cm is possible using either the resistive touch screen as the sensor or with a single conductive plate, with communication to the host via the serial interface.

The SX8674 and SX8675 also integrate a haptics motor driver for Linear Resonant Actuator (LRA) and Eccentric Rotating Mass (ERM) micro motors with up to 250mA drive current. Haptics control can be performed using either an external PWM signal or the I2C serial interface, providing simple host interfacing and minimizing its I/O requirement.

Integrated very high ESD protection, of up to $\pm 15\text{kV}$ on display inputs not only saves cost and board area, but also increases application reliability.

The three devices have an ambient operating temperature range of -40°C to $+85^{\circ}\text{C}$, and are offered in both a 4mm x 4mm, 20-lead QFN package and 2.07mm x 2.07mm 19-lead CSP package for space-conscious applications.

TYPICAL APPLICATIONS

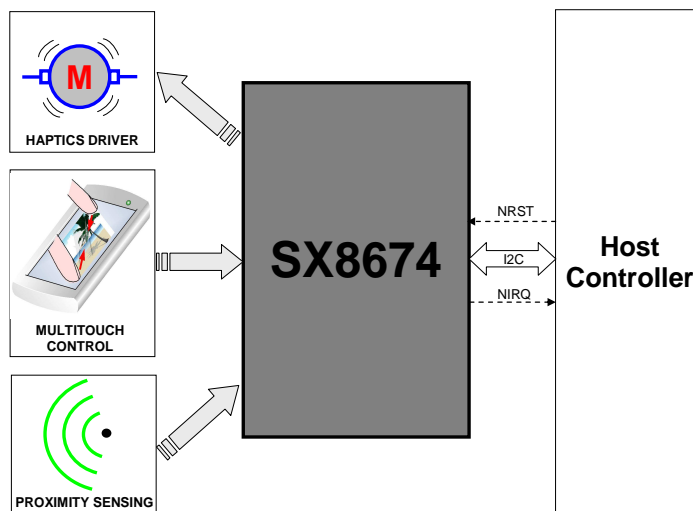
- Game Machines, Portable Music Players
- Mobile Phones
- DSC, DVR, Phones
- POS/POI Terminals
- Touch-Screen Monitors

ORDERING INFORMATION

Part Number	Package	Marking
SX8674IWLTRT	QFN-20	RA39
SX8674ICSTRT	WLCSP-19	
SX8675IWLTRT	QFN-20	RF9E
SX8675ICSTRT	WLCSP-19	
SX8676IWLTRT	QFN-20	RKL9
SX8676ICSTRT	WLCSP-19	
SX8674EVMK	Evaluation Kit	

KEY PRODUCT FEATURES

- Low Voltage Operation
 - 2.3V to 3.6V Supply
 - Integrated Low Drop Out (LDO) Regulator
- Low Power Consumption
 - 30uA@2.3V 8ksps (ESR)
 - 0.4uA Shut-Down Current
- 4/5-Wire Touchscreen Interface
 - Precision, Ratiometric 12-bit ADC
 - Up to 5000 (X-Y) coordinates/second (c/s)
 - Programmable Digital Filtering/Averaging
 - Touch Pressure Measurement (4-Wire)
 - Programmable Operating Mode (Manual, Pen Detect, Pen Trigger)
- Capacitive Proximity Sensing (SX8674/76)
 - No Additional Components Required
 - Uses Resistive Touchscreen or a Simple Conductive Area as the Sensor
 - >5 cm Detection Distance
 - 8uA @ 200ms Scan Period
 - Fully Programmable (Sensitivity, etc)
- Haptics Driver for LRA and ERM (SX8674/75)
 - Haptics Waveform Generation Control (I2C or PWM Input)
 - Short Circuit Protection
 - Early Warning and Over-Temperature Monitoring and Protection
- 400kHz I2C Serial Interface
- Several Host Operating Modes Available
 - Maskable Interrupt Output (NIRQ)
 - Real-time Events Monitoring (AUX1-3)
 - Polling (I2C)
- Hardware, Software, and Power-On Reset
- -40°C to $+85^{\circ}\text{C}$ Operating Temperature Range
- 15kV HBM & IEC ESD Protection
- Small Footprint Packages
- Pb & Halogen Free, RoHS/WEEE compliant





SX8674/SX8675/SX8676

Haptics Enabled Multitouch 4/5-Wire
Resistive Touchscreen Controller with Proximity Sensing

ADVANCED COMMUNICATIONS & SENSING

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ADVANCED COMMUNICATIONS & SENSING

1 GENERAL DESCRIPTION

1.1 Marking Information

1.1.1 SX8674

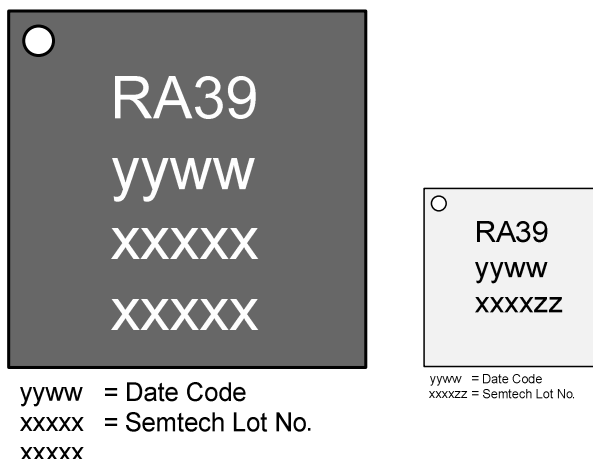


Figure 1 – Marking Information – QFN(left) – CSP(right)

1.1.2 SX8675

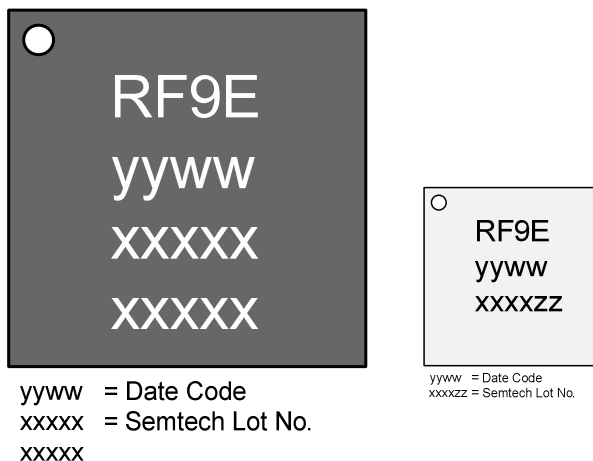


Figure 2 – Marking Information – QFN(left) – CSP(right)

1.1.3 SX8676

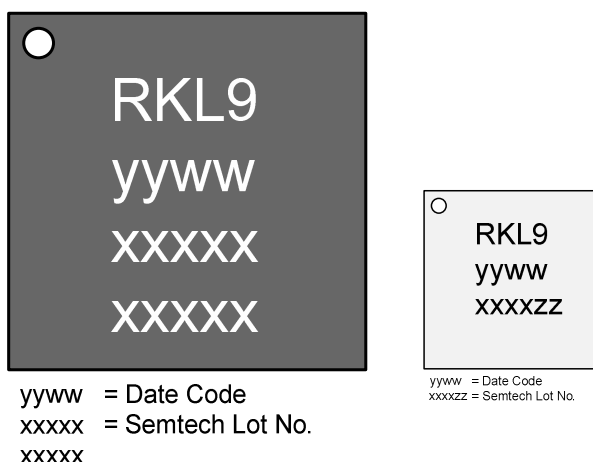


Figure 3 – Marking Information – QFN(left) – CSP(right)

ADVANCED COMMUNICATIONS & SENSING

1.2 Pin Diagrams

1.2.1 QFN Package

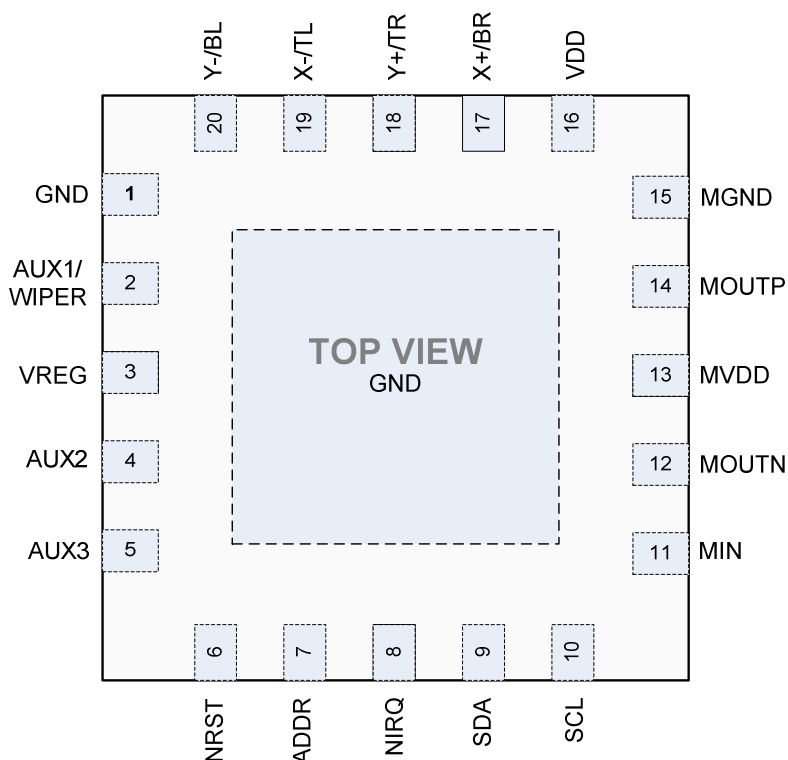


Figure 4 – Pin Diagram – QFN

Note that haptics pins (MVDD, MGND, MIN, MOUTN, MOUTP) are not used on SX8676. (Cf. §1.3)

1.2.2 CSP Package

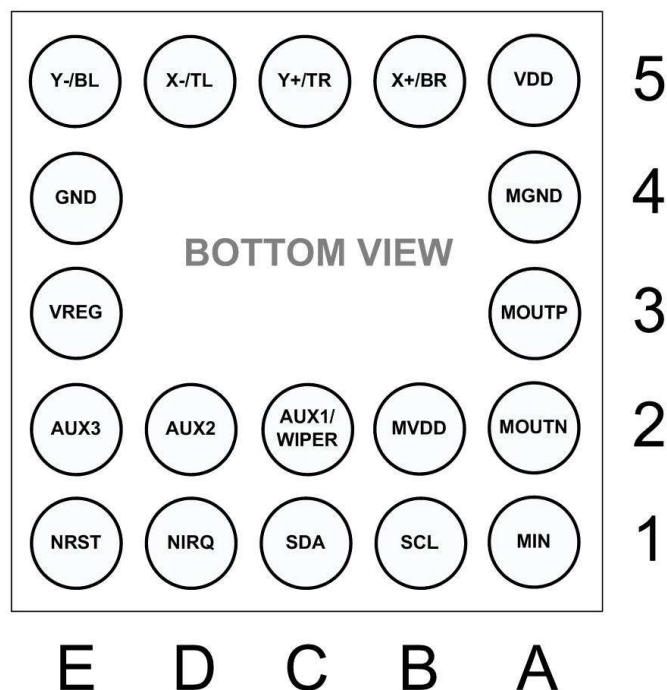


Figure 5 – Pin Diagram - CSP

Note that haptics pins (MVDD, MGND, MIN, MOUTN, MOUTP) are not used on SX8676. (Cf. §1.3)

ADVANCED COMMUNICATIONS & SENSING

1.3 Pin Description

Name	Type	Description
VDD	P	Main Power Supply
GND	P	Main Ground
VREG	P	Internal Regulator Output (must be connected to an external capacitor; see §13)
MVDD	P	SX8674/75 : Haptics Motor Power Supply SX8676 : Not used, connect to VDD.
MGND	P	SX8674/75 : Haptics Motor Ground (must be electrically connected to GND) SX8676 : Not used, connect to GND.
MOUTP	AO	SX8674/75 : Haptics Motor Positive Drive SX8676 : Not used, do not connect.
MOUTN	AO	SX8674/75 : Haptics Motor Negative Drive SX8676 : Not used, do not connect.
MIN	DI	SX8674/75 : Haptics Motor PWM/Clock Input SX8676 : Not used, connect to GND.
X+/BR	A	<ul style="list-style-type: none"> 4-wire Touchscreen : X+ Electrode 5-wire Touchscreen : Bottom Right (BR) Electrode
Y+/TR	A	<ul style="list-style-type: none"> 4-wire Touchscreen : Y+ Electrode 5-wire Touchscreen : Top Right (TR) Electrode
X-/TL	A	<ul style="list-style-type: none"> 4-wire Touchscreen : X- Electrode 5-wire Touchscreen : Top Left (TL) Electrode
Y-/BL	A	<ul style="list-style-type: none"> 4-wire Touchscreen : Y- Electrode 5-wire Touchscreen : Bottom Left (BL) Electrode
AUX1/WIPER	D/A	<ul style="list-style-type: none"> 4-wire Touchscreen : First Programmable Auxiliary Function (see §9) 5-wire Touchscreen : WIPER Electrode
AUX2	D/A	Second Programmable Auxiliary Function (see §9)
AUX3	D/A	Third Programmable Auxiliary Function (see §9)
ADDR	DI	I2C Address Selection (QFN only, internally connected to GND on CSP)
SCL	DI	I2C Clock Input
SDA	DIO	I2C Data Input/Output
NIRQ	DO	Interrupt Output (active low)
NRST	DI	Reset Input (active low)

A/D/I/O/P: Analog/Digital/Power/Input/Output

Table 1 – Pin Description

ADVANCED COMMUNICATIONS & SENSING

1.4 Block Diagram

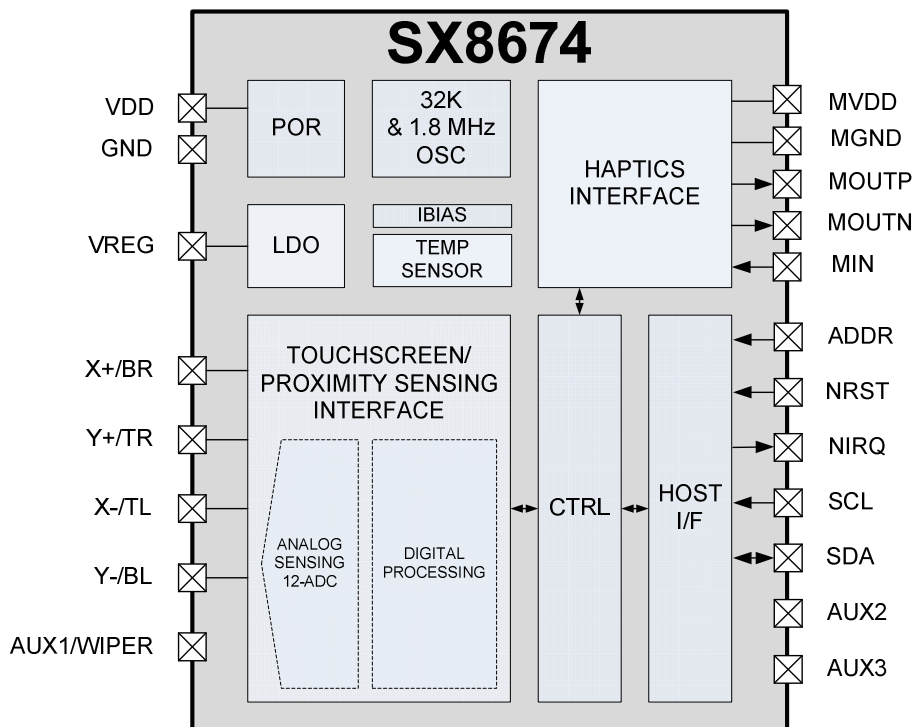


Figure 6 – SX8674 Block Diagram

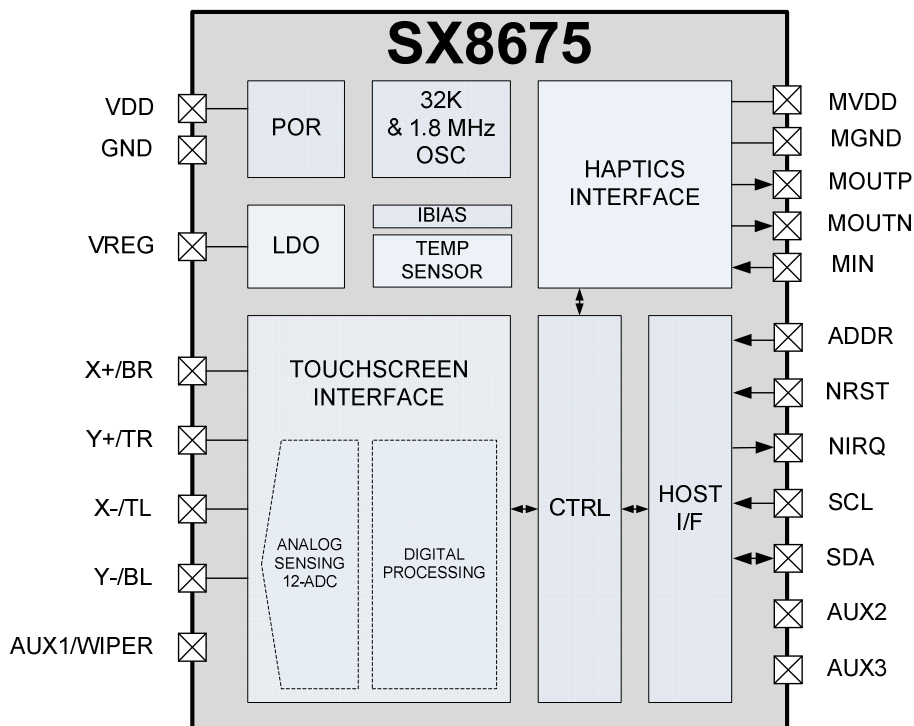


Figure 7 – SX8675 Block Diagram

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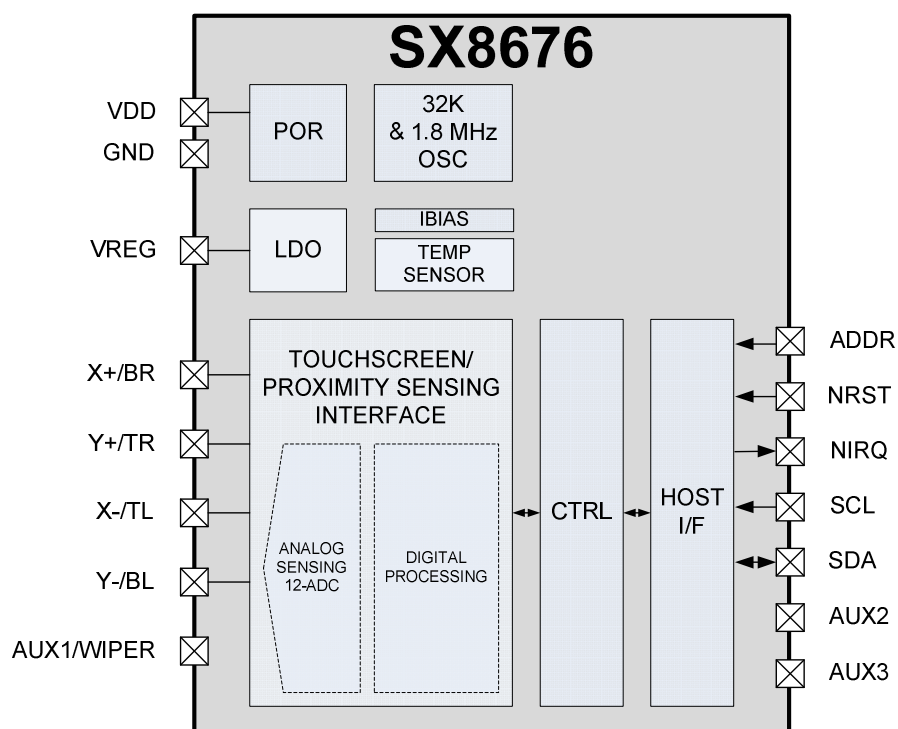


Figure 8 – SX8676 Block Diagram

ADVANCED COMMUNICATIONS & SENSING

2 ELECTRICAL CHARACTERISTICS

2.1 Absolute Maximum Ratings

Stress above the limits listed in the following table may cause permanent failure. Exposure to absolute ratings for extended time periods may affect device reliability. The limiting values are in accordance with the Absolute Maximum Rating System (IEC 134). All voltages are referenced to ground (GND).

Symbol	Description	Conditions	Min	Max	Unit
VABS	Voltage applied on any pin		- 0.5	3.9	V
VESDHBM	Electrostatic handling Human Body Model (HBM)	X+/BR, Y+/TR, X-/TL, Y-/BL, VDD, MVDD	+/-15 ⁽¹⁾ , +/-8 ⁽²⁾		kV
		Other pins	+/-8 ⁽²⁾		
VESDCDM	Electrostatic handling Charged Device Model (CDM)	X+/BR, Y+/TR, X-/TL, Y-/BL, VDD, MVDD	+/-1		kV
		Other pins	+/-1		
VESDMM	Electrostatic handling Machine Model (MM)	X+/BR, Y+/TR, X-/TL, Y-/BL, VDD, MVDD	+/-250		V
		Other pins	+/-250		
VESDCD	Electrostatic handling Contact Discharge (CD)	X+/BR, Y+/TR, X-/TL, Y-/BL, VDD, MVDD	+/-15		kV
TAMB	Operating ambient temperature		-40	+85	°C
TJUN	Operating junction temperature		-40	+125	°C
TSTOR	Storage temperature		-55	+150	°C
ILAT	Latch-up current ⁽³⁾		+/-100		mA

(1) Tested to TLP (10A)

(2) Tested to JEDEC standard JESD22-A114

(3) Tested to JEDEC standard JESD78

Table 2 - Absolute Maximum Ratings

2.2 Thermal Characteristics

Symbol	Description	Conditions	Min	Max	Unit
θJAQ	Thermal Resistance Junction – Ambient QFN package	-	-	30.5	°C/W
θJAW	Thermal Resistance Junction – Ambient WLCSP package	-	-	29	°C/W

Table 3 – Thermal Characteristics

2.3 Electrical Specifications

Table below applies to full supply voltage and temperature range, unless otherwise specified. Typical values are given for T_A = +25°C, VDD=VDDM=3.3V.

Symbol	Description	Conditions	Min	Typ.	Max	Unit
Supply						
VDD	Main supply voltage	-	2.3	-	3.6	V
IDD	Main supply current	OFF (MAN mode, no command, HAPT OFF)	-	0.4	0.75	uA
		WAIT (PENDET/TRG mode, pen up, PROX OFF, HAPT OFF)	-	1.7	-	
		TOUCH1 (PENTRG mode, pen down, X+Y, RATE=4kcps, Nfilt=1, POWDLY=0.5us, touchscreen current excluded, HAPT OFF, VDD=2.3V)	-	30	-	
		TOUCH2 (PENTRG mode, pen down, X+Y, RATE=3kcps, Nfilt=7, POWDLY=0.5us, touchscreen current excluded, HAPT OFF)	-	120	160	

ADVANCED COMMUNICATIONS & SENSING

Symbol	Description	Conditions	Min	Typ.	Max	Unit
		PROX (PENDET/TRG mode, pen up, TOUCHRATE=80cps, PROX ON, SCANPERIOD=200ms, HIGHIM=ON, SENSITIVITY=Max, FREQ=150kHz, BOOST=OFF, HAPT OFF)	-	8	20	
		HAPT (MAN mode, no command, LRA-PWM mode, MIN= 44.8kHz/50%, GAIN = Max, BW = 100, MOUTP/N floating, Squelch=011)	-	115	145	
MVDD	Haptics supply voltage	-	VDD	-	3.6	V
		OFF	-	0.01	1	μA
MIDD	Haptics supply current	SQUELCH (LRA-PWM mode, MIN= 44.8kHz/50%, GAIN = Max, BW = 100, MOUTP/N floating, Squelch=011)	-	6	10	μA
Digital I/Os (ADDR, SCL, SDA, NRST, NIRQ, AUX1, AUX2, AUX3, MIN)						
VIH	High level input voltage	SCL, SDA, NRST	0.8*VDD	-	3.6	V
		Other pins	0.8*VDD	-	VDD+0.2	V
VIL	Low level input voltage	-	-0.3	-	0.8	V
ILEAK	Input leakage current	-	-1	-	1	μA
CI	Input capacitance	-	-	5	-	pF
VOH	High level output voltage	IOH = 4mA	0.8*VDD	-	-	V
VOL	Low level output voltage	IOL = 4mA	-	-	0.4	V
VPULL	External pull-up voltage	SCL, SDA, NRST, NIRQ	-	-	3.6	V
Haptics Interface						
IDRV	Maximum drive current (MOUTP/MOUTN)	MVDD = 3.6V	-	250	-	mA
VOFF	Output squelch differential error (from 0V ideal)	LRA or ERM, PWM or I2C, AmplitudeCode within squelch range, GAIN = Max, BW = 100, MOUTP/N floating, Squelch=011	0 ⁽¹⁾	0	0 ⁽¹⁾	mV
VERR	Output differential error (from 1.135V ideal)	LRA or ERM, I2C, AmplitudeCode = +127 (Max) GAIN = Min, BW = 100, MOUTP/N floating	125 ⁽²⁾	0	125 ⁽²⁾	mV
VDRV	Drive voltage (MOUTP/MOUTN)	-	-	-	VDDM	V
VDROP	Drop voltage (MOUTP/MOUTN)	From MVDD/MGND, @250mA	-	-	150	mV
ISHORT	Short-circuit detection current	Measured @MIDD	-	300	-	mA
FMINC	Motor input (MIN) frequency in I2C mode	40-60% duty cycle	-	-	50	MHz
FMINP	Motor input (MIN) frequency in PWM mode	HAPTRANGE = 0	12.8	-	25.6	kHz
		HAPTRANGE = 1	25.6	-	51.2	kHz
DCMIN	Motor input (MIN) duty cycle in PWM mode		2	-	98	%
TWRNG	Warning temperature	Junction temperature	-	120	-	°C
TALRM	Alarm temperature		-	155	-	
Touchscreen Interface						
ARES	ADC resolution		12	-	-	bits
AOFF	ADC offset		-	± 1	-	LSB
AGE	ADC gain error	At full scale	-	0.5	-	
ADNL	ADC differential non-linearity		-	± 1	-	
AINL	ADC integral non-linearity		-	± 1.5	-	
RBIAS	Biasing resistance		-	5	-	Ω
Proximity Sensing Interface						
CDC	External capacitance to be compensated	-	-	-	300	pF
tPROX	Scan period (reaction time)	Programmable	-	200	-	ms

ADVANCED COMMUNICATIONS & SENSING

Symbol	Description	Conditions	Min	Typ.	Max	Unit
Reset						
VPOR	Power-On-Reset voltage	Cf. §10	-	1.3	-	V
t_{RESET}	Reset time after POR	Cf. §10	-	-	1	ms
t_{PULSE}	Reset pulse from host uC	Cf. §10	1	-	-	us
I2C Interface						
f_{SCL}	SCL clock frequency	-	-	-	400	kHz
$t_{HD;STA}$	Hold time (repeated) START condition	-	0.6	-	-	μs
t_{LOW}	LOW period of the SCL clock	-	1.3	-	-	μs
t_{HIGH}	HIGH period of the SCL clock	-	0.6	-	-	μs
$t_{SU;STA}$	Set-up time for a repeated START condition	-	0.6	-	-	μs
$t_{HD;DAT}$	Data hold time	-	0	-	-	μs
$t_{SU;DAT}$	Data set-up time	-	100	-	-	ns
t_r	Rise time of both SDA and SCL	-	$20+0.1C_b$	-	300	ns
t_f	Fall time of both SDA and SCL	-	$20+0.1C_b$	-	300	ns
$t_{SU;STO}$	Set-up time for STOP condition	-	0.6	-	-	μs
t_{BUF}	Bus free time between a STOP and START condition	-	1.3	-	-	μs
C_b	Capacitive load for each bus line	-	-	-	400	pF
t_{SP}	Pulse width of spikes suppressed by the input filter	Up to 0.3xVDD from GND, down to 0.7xVDD from VDD	50	-	-	ns
Miscellaneous						
FOSCL	Low frequency internal oscillator	-	-	32	-	kHz
FOSCH	High frequency internal oscillator	-	-	1.8	-	MHz

⁽¹⁾ Guaranteed by design.

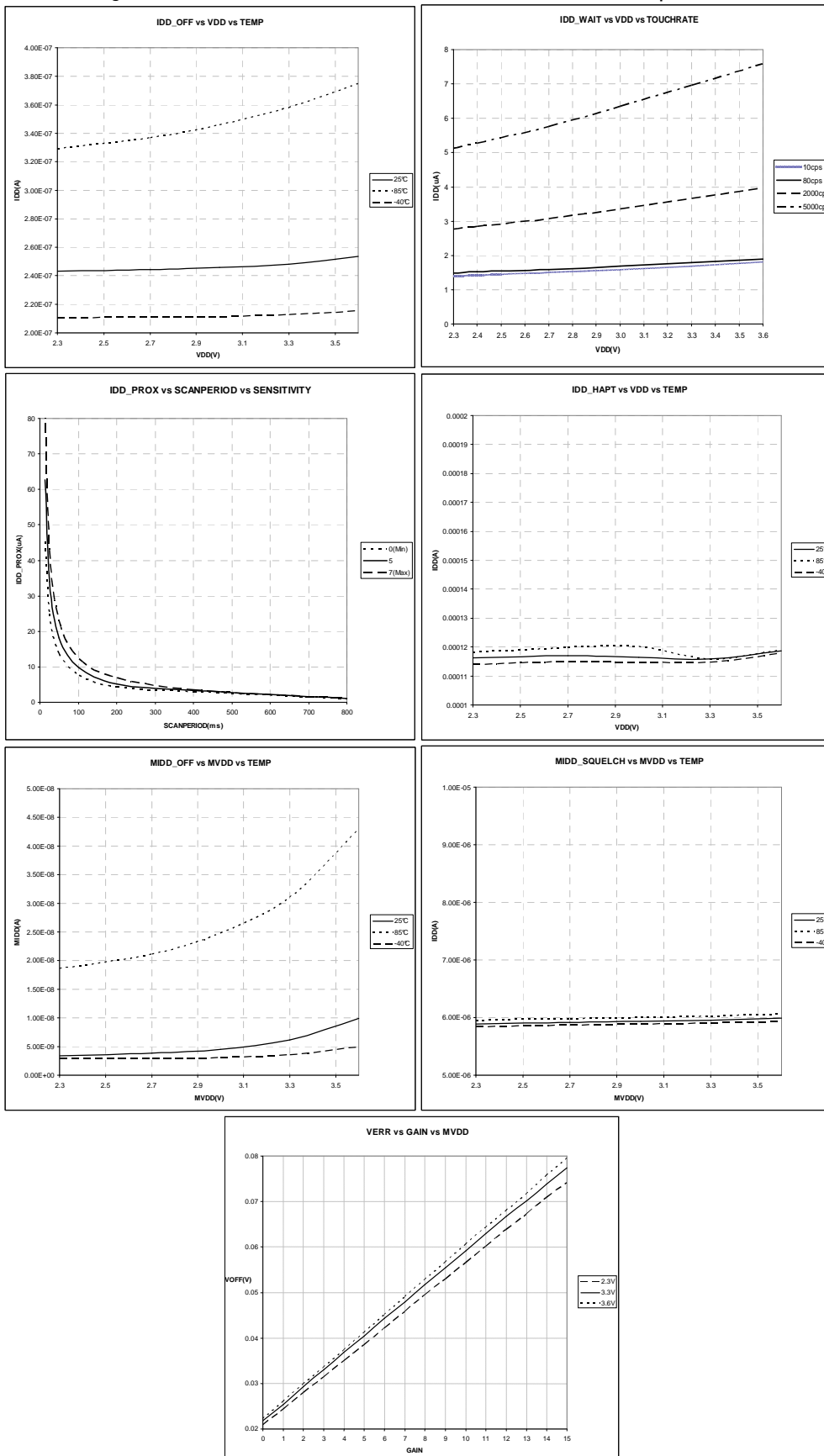
⁽²⁾ PWM mode can introduce an additional error of 2.5% of full scale.

Table 4 – Electrical Specifications

ADVANCED COMMUNICATIONS & SENSING

3 TYPICAL OPERATING CHARACTERISTICS

Conditions as defined in §2.3, $T_A = +25^\circ\text{C}$, $V_{DD} = V_{DDM} = 3.3\text{V}$ unless otherwise specified.



ADVANCED COMMUNICATIONS & SENSING

4 TOUCHSCREEN INTERFACE

4.1 Introduction

The purpose of the touchscreen interface is to measure and extract touch information like coordinates and pressure. This is done in two steps, first an ADC measures the analog signal coming from the screen, and then digital processing is performed to consolidate the data.

As illustrated below the chip's touchscreen interface is compatible with both 4-wire and 5-wire touchscreens. Touchscreen type is defined by parameter TSTYPE.

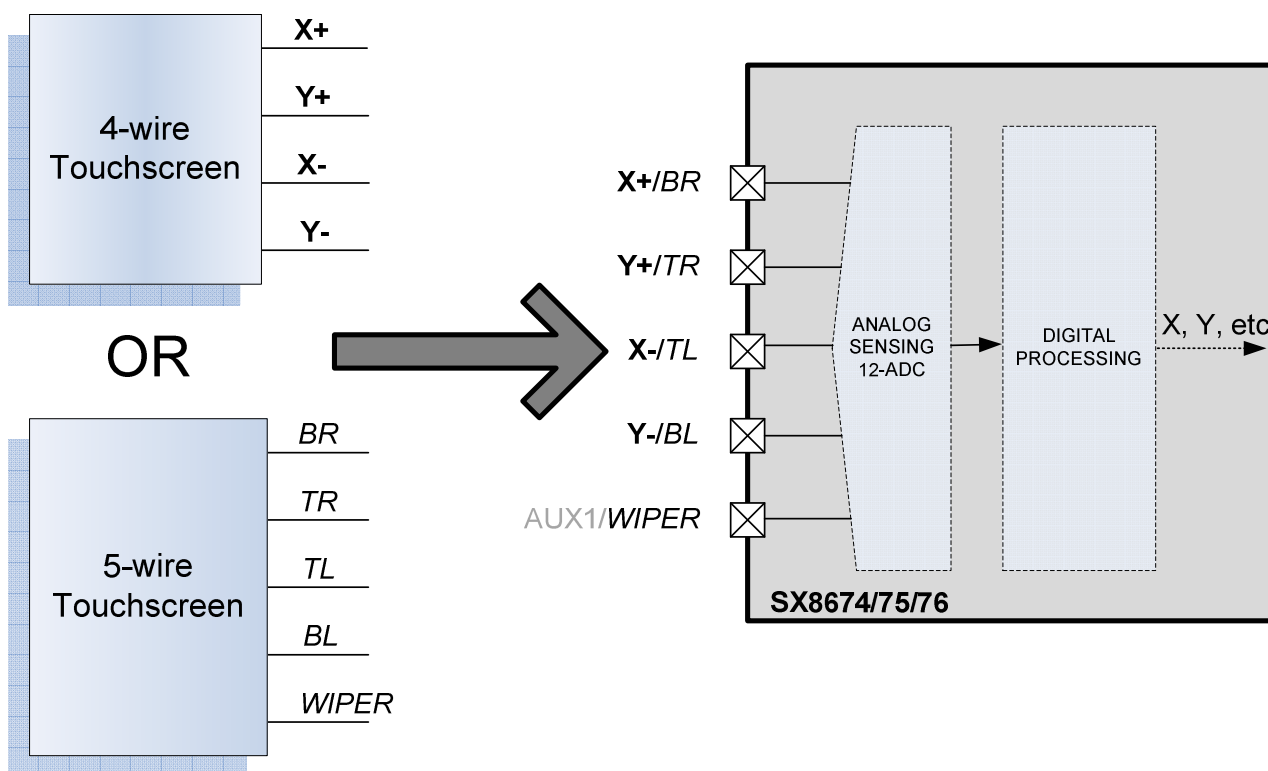


Figure 9 – Touchscreen Interface Overview

A 4-wire resistive touch screen consists in two (resistive) conductive sheets separated by an insulator when not pressed. Each sheet is connected through 2 electrodes at the border of the sheet. When a pressure is applied on the top sheet, a connection with the lower sheet is established.

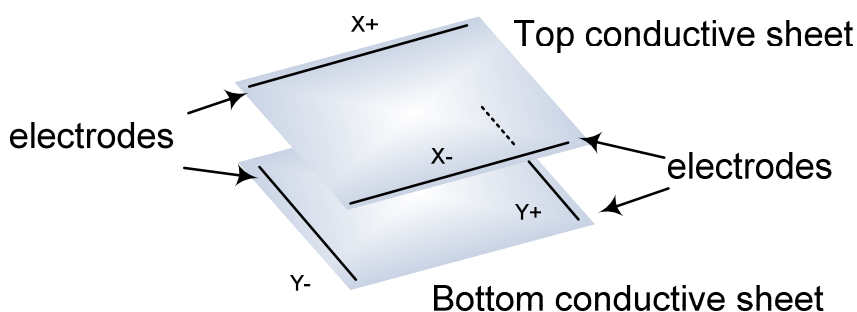


Figure 10 – 4-wire Touchscreen

A 5-wire resistive touch screen consists in two (resistive) conductive sheets separated by an insulator when not pressed. 4 electrodes are connected on the 4 corners of the bottom conductive sheet. They are referred as Top Left (TL), Top Right (TR), Bottom Left (BL) and Bottom Right (BR).

The fifth wire (WIPER) is used for sensing the top sheet voltage. When a pressure is applied on the top sheet, a connection with the lower sheet is established.

ADVANCED COMMUNICATIONS & SENSING

Higher reliability and better endurance are the advantages of 5-wire touchscreens but they do not allow pressure measurement

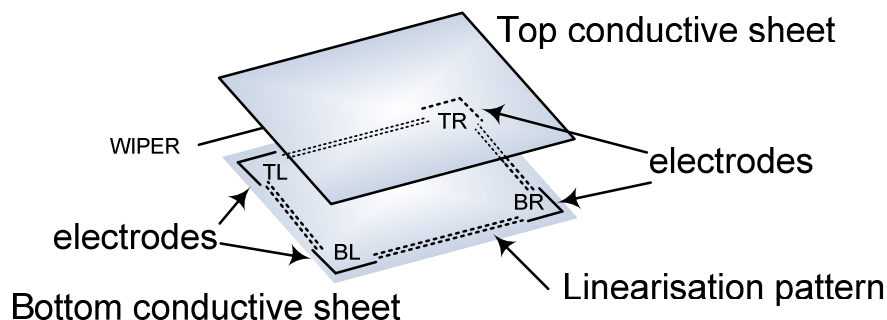


Figure 11 – 5-wire Touchscreen

4.2 Coordinates Measurement

4.2.1 4-wire Touchscreen

The electrode plates are internally connected through terminals X+, X- and Y+, Y- to an analog to digital converter (ADC) and a reference voltage (Vref). The resistance between the terminals X+ and X- is defined by Rxtot. Rxtot will be split in 2 resistors, R1 and R2, in case the screen is touched. Similarly, the resistance between the terminals Y+ and Y- is represented by R3 and R4. The connection between the top and bottom sheet is represented by the touch resistance (RT).

In order to measure the Y coordinate, the top resistive sheet (Y) is biased with a voltage source (Vref). Resistors R3 and R4 determine a voltage divider proportional to the Y position of the contact point. Since the converter has a high input impedance, no current flows through R1 (and RT) so that the voltage X+ at the converter input is given by the voltage divider created by R3 and R4.

The X coordinate is measured in a similar fashion with the bottom resistive sheet (X) biased to create a voltage divider by R1 and R2, while the voltage on the top sheet is measured through R3.

The resistance RT is the resistance obtained when a pressure is applied on the screen. RT is created by the contact area of the X and Y resistive sheet and varies with the applied pressure.

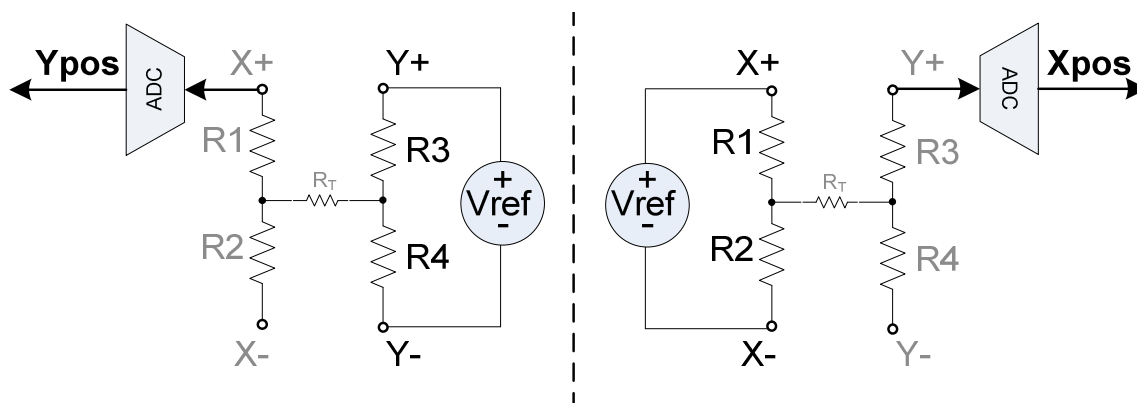


Figure 12 – 4-wire Touchscreen Coordinates Measurement

The X and Y positions output by the ADC correspond to the formulas below:

$$X_{pos} = 4095 \cdot \frac{R2}{R1 + R2} \quad Y_{pos} = 4095 \cdot \frac{R4}{R3 + R4}$$

4095 corresponds to the max output value of the ADC (12 bits => $2^{12} - 1$).

For example, a touch in the center of the screen will output $(X_{pos}, Y_{pos}) = \sim(2048, 2048)$

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4.2.2 5-wire Touchscreen

5-wire touchscreen coordinates measurement is performed similarly by biasing opposite corner pairs in either X or Y directions on the lower panel, and converting the voltage appearing on the wiper panel with the ADC.

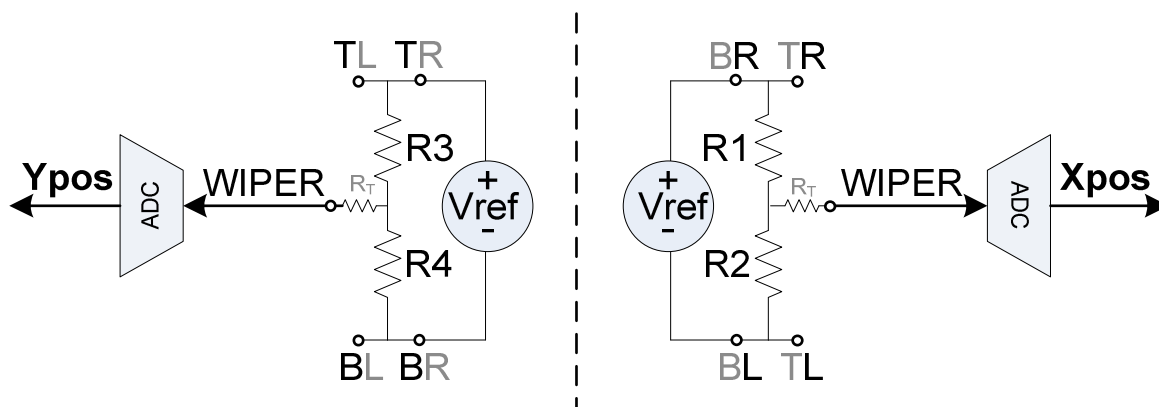


Figure 13 – 5-wire Touchscreen Coordinates Measurement

The X and Y positions output by the ADC correspond to the formulas below:

$$X_{pos} = 4095 \cdot \frac{R_2}{R_1 + R_2} \quad Y_{pos} = 4095 \cdot \frac{R_4}{R_3 + R_4}$$

4095 corresponds to the max output value of the ADC (12 bits $\Rightarrow 2^{12} - 1$).

For example, a touch in the center of the screen will output $(X_{pos}, Y_{pos}) = \sim(2048, 2048)$

4.3 Pressure Measurement (4-wire only)

The pressure measurement consists in extracting the touch resistance R_T via two additional setups $z1$ and $z2$ illustrated below. The smaller R_T , the more common touched surface there is between top and bottom plates and hence the more “pressure” there is by the user.

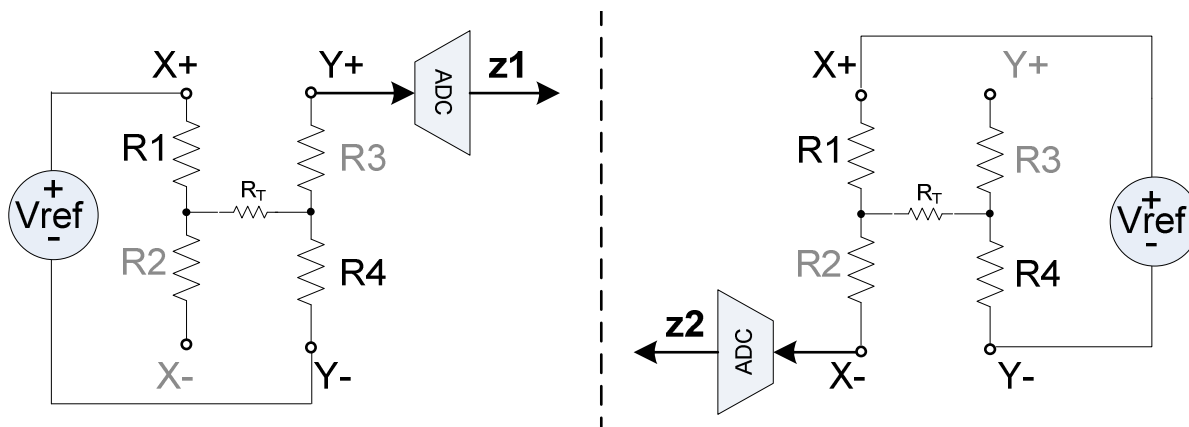


Figure 14 – Pressure Measurement

The $z1$ and $z2$ values output by the ADC correspond to the formulas below:

$$z1 = 4095 \cdot \frac{R_4}{R_1 + R_4 + R_T} \quad z2 = 4095 \cdot \frac{R_4 + R_T}{R_1 + R_4 + R_T}$$

The X and Y total sheet resistance ($R_{xtot} = R_1 + R_2$, $R_{ytot} = R_3 + R_4$) are known from the touch screen supplier.

R_4 is proportional to the Y coordinate and its value is given by the total Y plate resistance R_{ytot} multiplied by the fraction of the Y position over the full coordinate range.

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$$R_{xtot} = R1 + R2$$

$$R_{ytot} = R3 + R4$$

$$R4 = R_{ytot} \cdot \frac{Y_{pos}}{4095}$$

Re-arranging z1 and z2 gives:

$$R_T = R4 \cdot \left[\frac{z2}{z1} - 1 \right]$$

This finally results in:

$$R_T = R_{ytot} \cdot \frac{Y_{pos}}{4095} \cdot \left[\frac{z2}{z1} - 1 \right]$$

The touch resistance calculation above hence requires three channel measurements (Ypos, z2 and z1) and one specification data (Rytot).

An alternative calculation method is using Xpos, Ypos, one z channel and both Rxtot and Rytot as shown in the next calculations.

R1 is inversely proportional to the X coordinate:

$$R1 = R_{xtot} \cdot \left[1 - \frac{X_{pos}}{4095} \right]$$

Substituting R1 and R4 into z1 and rearranging terms gives:

$$R_T = \frac{R_{ytot} \cdot Y_{pos}}{4095} \cdot \left[\frac{4095}{z1} - 1 \right] - R_{xtot} \cdot \left[1 - \frac{X_{pos}}{4095} \right]$$

Please note that the chip only outputs z1, z2, etc. The calculation of R_T itself with the formulas above must be performed by the host.

4.3.1 Bias Time (POWDLY)

In order to perform correct measurements, some time must be given for the touch screen to reach a proper Vref bias level before the conversion is actually performed. It is a function of the PCB trace resistance connecting the chip to the touchscreen and also the capacitance of the touchscreen. If tau is this RC time constant, then POWDLY duration must be programmed to 10 tau to reach 12 bits accuracy.

Adding a capacitor from the touch screen electrodes to ground may also be used to minimize external noise (if the touchscreen is used as the proximity sensor, make sure you do not exceed the maximum capacitive load for required for proper proximity sensing operation). The low-pass filter created with the capacitor may increase settling time requirement. Therefore, POWDLY can be used to stretch the acquisition period and delay conversion appropriately.

POWDLY can be estimated by the following formula:

$$PowDly = 10 \times R_{touch} \times C_{touch}$$

4.4 Pen Detection

The pen detection circuitry is used both to detect a user action and generate an interrupt or start an acquisition in PENDET and PENTRG mode respectively. Doing pen detection prior to conversion avoids feeding the host with dummy data and saves power. Pen detection is also used to disable and resume proximity sensing. For more details on pen detection usage please refer to §4.7.

A 4-wire touchscreen will be powered between X+ and Y- through a resistor RPNDT so no current will flow as long as no pressure is applied to the surface (see figure below). When a touch occurs, a current path is created bringing X+ to the level defined by the resistive divider determined by RPNDT and the sum of R1, RT and R4.

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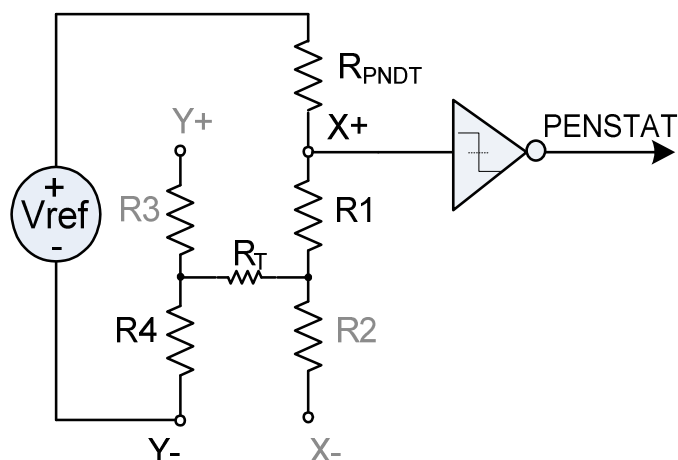


Figure 15 – 4-wire Touchscreen Pen Detection

When using a 5-wire touchscreen, the pen detection pull-up resistor R_{PNDT} and digital comparator continue to monitor the X+/BR pin as in 4-wire mode. The top panel is grounded via the WIPER pin to provide the grounding path for a screen touch event. When a touch occurs, a current path is created and will bring BR to the level defined by the resistive divider determined by R_{PNDT} and the sum of R_1 , R_T and R_W .

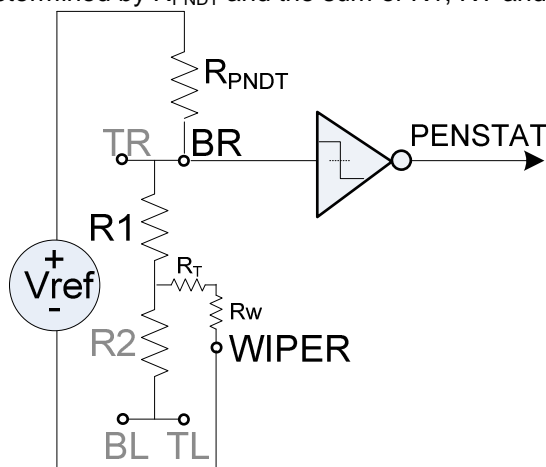


Figure 16 – 5-wire Touchscreen Pen Detection

R_{PNDT} can be configured to 4 different values to accommodate different screen resistive values.
 R_{PNDT} should be set to a value greater than $7 \times (R_{xtot} + R_{ytot})$, it is recommended to set it to max value.

Pen detection uses a bias time of $POWDLY/8$ (digital comparator => less precision required vs analog conversion). Increasing $POWDLY$ can improve the detection on panels with high resistance.

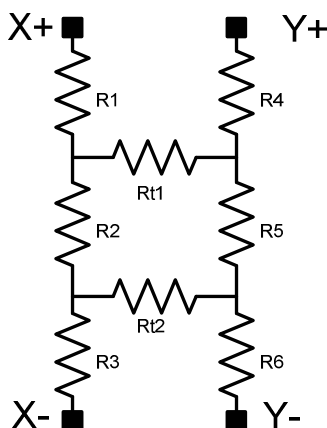
A pen touch will set the PENSTAT bit of the RegStat register which will generate an interrupt if enabled in RegIrqMsk.

A pen release will reset PENSTAT bit of the RegStat register which will generate an interrupt if enabled in RegIrqMsk.

4.5 Multitouch Measurement (4-wire only)

SX8674/75/76 support up to two simultaneous touches on any standard 4-wire touchscreen. The simplified model for dual-touch is given in figure below.

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$$R_{xtot} = R1 + R2 + R3$$

$$R_{ytot} = R4 + R5 + R6$$

Figure 17 – Dual-touch Simplified Model

The two contacts create touch resistances Rt1 and Rt2 between the two layers of the touchscreen.

The SX8674/75/76 perform on-chip specific multitouch measurements which the host retrieves and processes with a specific software enabling the detection of the gestures described in §13.3.

For optimum gesture detection, RmSelX and RmSelY parameters should be set according to table below.

X/Y Panel Resistance (Ω)	RmSelX/Y
100-187	000
188-312	001
313-938	010
939-1875	011
1876-4375	100
4376-9375	101
9376-18780	110
>18780	111

Table 5 – RmSelX/Y Selection Table

4.6 Digital Processing

The chip offers 4 types of data processing which allows the user to make trade-offs between data throughput, power consumption and noise rejection.

The parameter FILT is used to select the filter order Nfilt. The noise rejection will be improved with a high order to the detriment of power consumption. Each channel can be sampled up to 7 times and then processed to get a single consolidated coordinate.

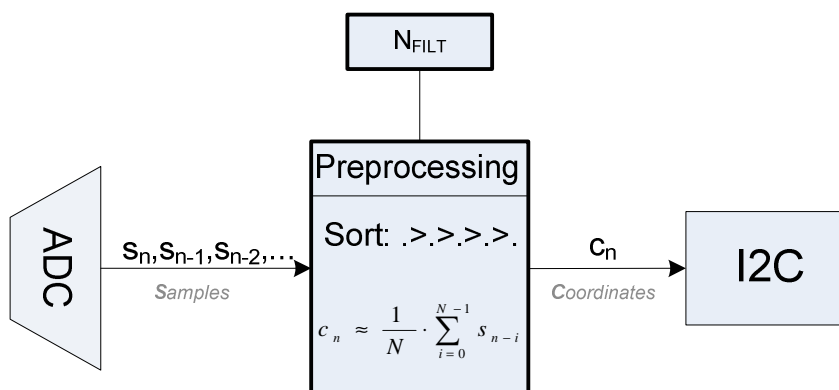


Figure 18 – Digital Processing Block Diagram

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FILT	Nfilt	Function
0	1	$c_n = s_n$ No average.
1	3	$c_n = \frac{1}{3} \cdot \frac{4079}{4095} (s_n + s_{n-1} + s_{n-2})$ 3 ADC samples are averaged.
2	5	$c_n = \frac{1}{5} \cdot \frac{4079}{4095} (s_n + s_{n-1} + s_{n-2} + s_{n-3} + s_{n-4})$ 5 ADC samples are averaged.
3	7	$s_{\max 1} \geq s_{\max 2} \geq s_a \geq s_b \geq s_c \geq s_{\min 1} \geq s_{\min 2}$ $c_n = \frac{1}{3} \cdot \frac{4079}{4095} (s_a + s_b + s_c)$ 7 ADC samples are sorted and the 3 center samples are averaged.

Table 6 – Digital Processing Functions

The parameter SETDLY sets the settling time between the consecutive conversions of the same channel.

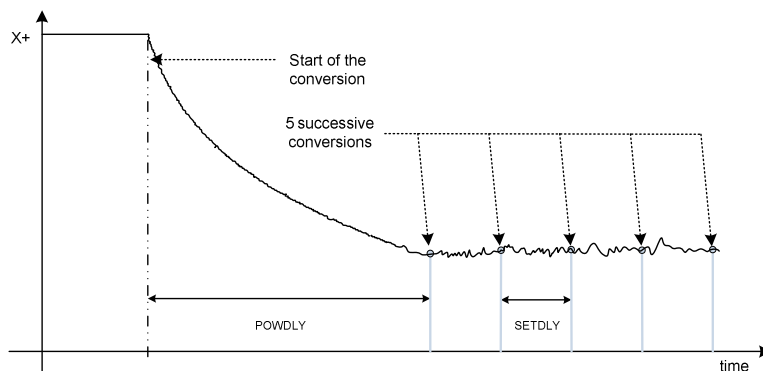


Figure 19 – POWDLY and SETDLY (FILT=2)

In most applications, SETDLY can be set to minimum (0.5us). However, in some particular applications where an accuracy of 1LSB is required SETDLY may need to be increased.

4.7 Host Operation

4.7.1 Overview

The chip has three operating modes that are configured using the I2C as defined in §11 :

- Manual (command 'MAN' and TOUCHRATE = 0).
- Pen detect (command 'PENDET' and TOUCHRATE > 0).
- Pen trigger (command 'PENTRG' and TOUCHRATE > 0).

At power-up the chip is set in manual mode.

4.7.2 Manual Mode (MAN)

In manual mode (MAN) the touchscreen interface is stopped and conversions must be manually triggered by the host using SELECT and CONVERT command

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When a command is received, the chip executes the associated tasks listed in table below and waits for the next command. It is up to the host to sequence all actions.

Pen detection is performed after each CONVERT command and if pen is not detected, no touch operation is performed. Following figures assume pen down. PENSTAT is not updated in MAN mode.

To enter MAN mode the host must send the MAN command and then set TOUCHRATE = 0.

Command	Actions
CONVERT(CHAN)	Select and bias CHAN Wait for the programmed settling time (POWDLY) Convert CHAN
SELECT(CHAN)	Select and bias CHAN

Table 7 – Manual Mode Commands

As illustrated in figure below the CONVERT command will bias the channel, wait for the programmed settling time (POWDLY), and run the conversion.

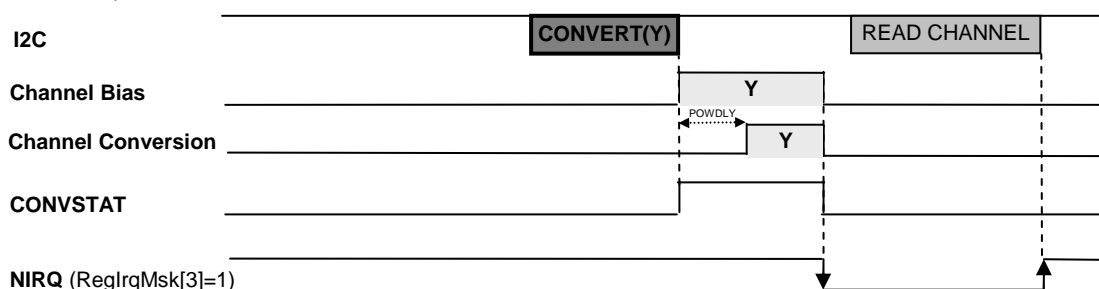


Figure 20 – Manual Mode – CONVERT Command (CHAN = Y; PROXSCANPERIOD = 0)

When the CONVERT command is used with CHAN=SEQ, multiple channels as defined in RegChnMsk are sampled. In this case, each channel will be sequentially biased during POWDLY before a conversion is started. At the end of each channel conversion the bias is automatically removed.

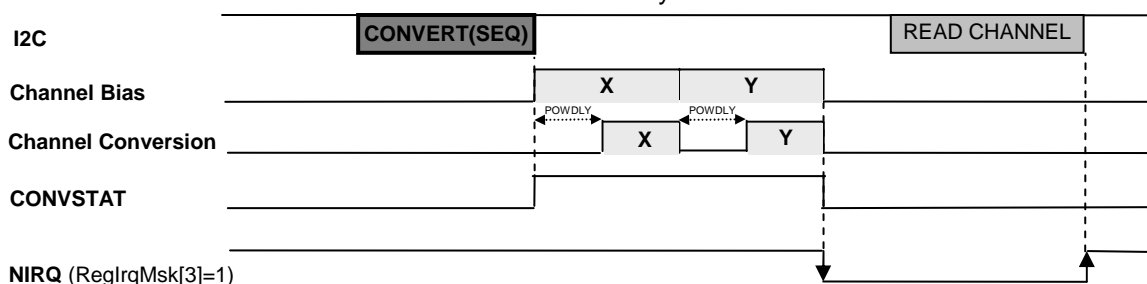
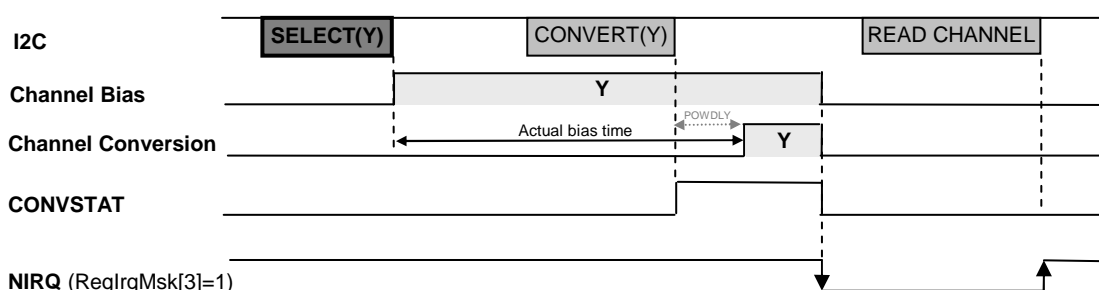


Figure 21 – Manual Mode – CONVERT Command (CHAN = SEQ = [X;Y]; PROXSCANPERIOD = 0)

In case the range of POWDLY settings available is not enough to cover the required settling time, one can use the SELECT command first to bias the channel, and then send the CONVERT command hence extending bias time. SELECT command cannot be used with CHAN=SEQ.



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Figure 22 – Manual Mode – SELECT command (CHAN = Y; PROXSCANPERIOD = 0)

At the end of the conversion(s) bit CONVSTAT will be reset which will trigger NIRQ falling edge (if enabled in RegIrqMsk). Host can then read channel data which will release NIRQ.

Please note that when the SELECT command is used, the channel is converted whatever the pen status (no pen detection performed).

4.7.3 Pen Detect Mode (PENDET)

In pen detect mode (PENDET) the chip will only run pen detection (continuously when pen is up, regularly as defined by TOUCHRATE when pen is down) and update PENSTAT bit in RegStat to be able to generate an interrupt (NIRQ) upon pen detection and/or release. No (touch) conversion is performed in this mode.

To enter PENDET mode the host must set TOUCHRATE > 0 and then send PENDET command. To quit PENDET mode and stop the touchscreen interface the host must enter MAN mode.

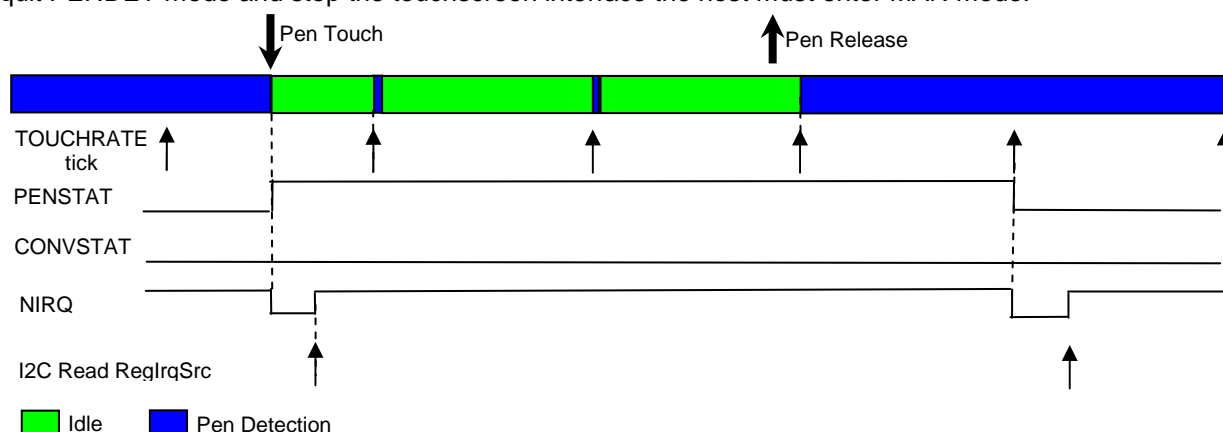


Figure 23 – Pen Detect Mode (RegIrqMsk[3:2] = 11 ; PROXSCANPERIOD = 0)

Please note that the next pen detection is not performed as long as NIRQ is low. If the host is too slow and doesn't read IrqSrc before next TOUCHRATE tick, no operation is performed and this TOUCHRATE tick is simply ignored until next one.

4.7.4 Pen Trigger Mode (PENTRG)

In pen trigger mode (PENTRG) the chip will perform pen detection (continuously when pen is up, regularly as defined by TOUCHRATE when pen is down) and if pen is down, will be followed by a conversion as defined in RegChanMsk. The chip will update CONVSTAT bit in RegStat and will be able to generate an interrupt (NIRQ) upon conversion completion. The chip will also update PENSTAT bit in RegStat and will be able to generate an interrupt (NIRQ) upon pen detection and/or release.

The PENTRG mode offers the best compromise between power consumption and coordinate throughput. To enter PENTRG mode the host must set TOUCHRATE > 0 and then send PENTRG command. To quit PENTRG mode and stop the touchscreen interface the host must enter MAN mode.

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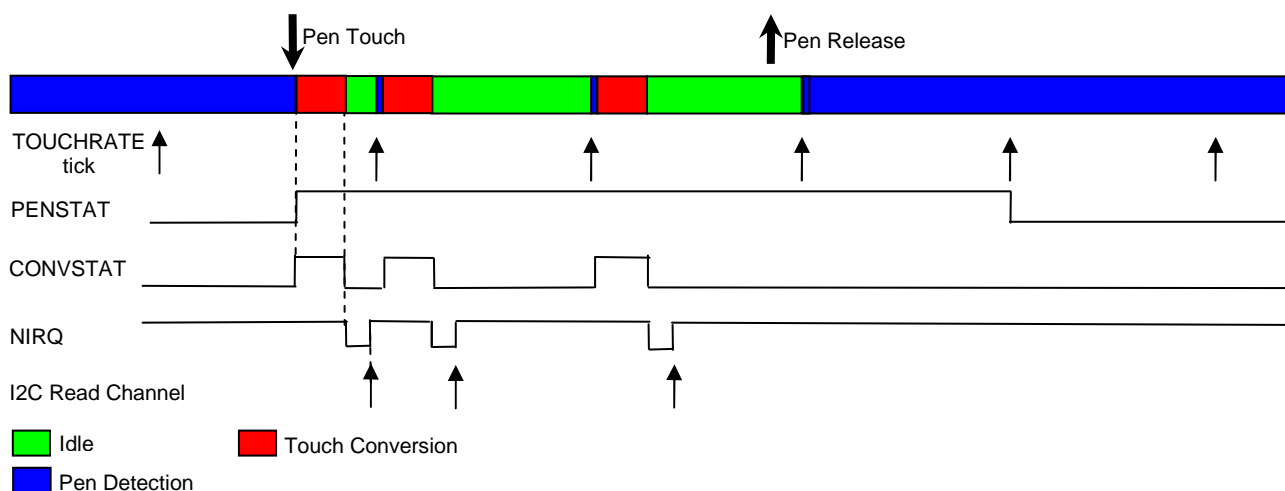


Figure 24 – Pen Trigger Mode ($\text{RegIrqMsk}[3:2] = 10$; $\text{PROXSCANPERIOD} = 0$)

Please note that to prevent data loss, the next pen detection and conversion are not performed as long as all current channel data (i.e. channels selected in RegChanMsk) have not been read. If the host is too slow and doesn't read all channel data before next TOUCHRATE tick, no operation is performed and this TOUCHRATE tick is simply ignored until next one.

4.7.5 Maximum Throughput vs. TOUCHRATE setting

In PENTRG mode the TOUCHRATE parameter is used to define the required coordinate's throughput/rate. However, as previously mentioned, in order for a new conversion to be performed the current conversion must be completed and all relevant channel data must have been read by the host. If this condition is not met when the next TOUCHRATE tick occurs, the tick is ignored and the condition checked again at the next one. This will result in reduced actual rate vs what has been programmed in the TOUCHRATE parameter.

This is illustrated in figures below.

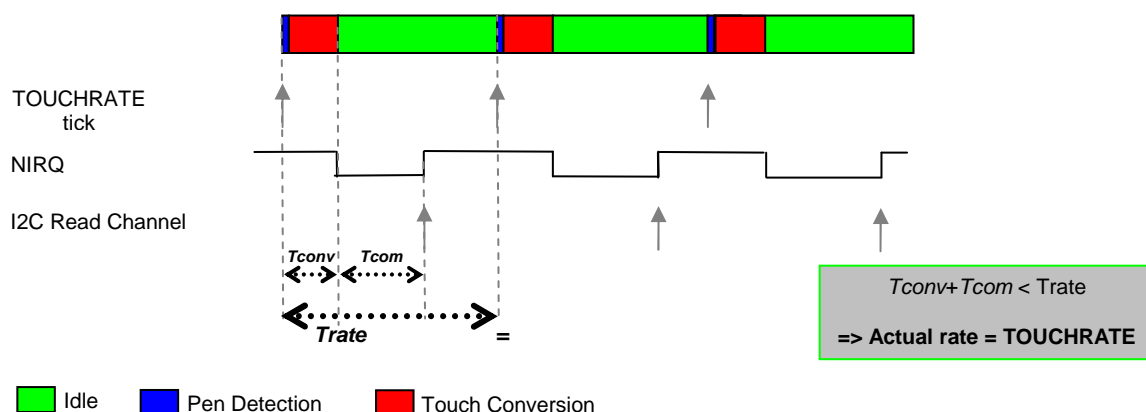


Figure 25 – Correct TOUCHRATE setting

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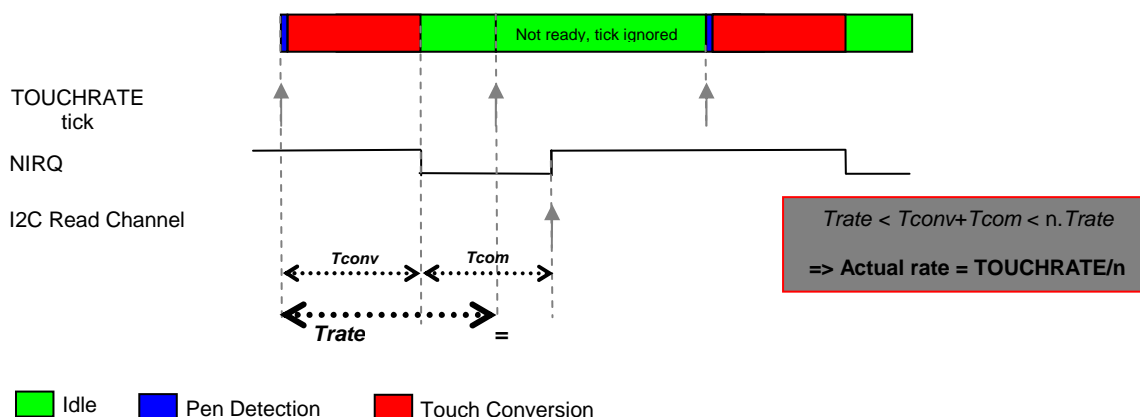


Figure 26 – Incorrect (too high) TOUCHRATE setting

In order to prevent this, one can estimate the maximum throughput achievable and set TOUCHRATE parameter accordingly.

$$\text{MaxThroughput} = 1 / (T_{conv} + T_{com})$$

T_{com} is the time between the end of conversion (ie NIRQ falling edge) and the end of channel data reading (i.e. NIRQ rising edge). Maximum throughput implies that the host reacts “instantaneously” to NIRQ falling edge:

$$T_{com} \approx (8 + 16 \times N_{chan}) \times T_{I2C}$$

T_{conv} is the total conversion time:

$$T_{conv}(\mu s) = 47 \cdot T_{osc} + N_{chan} \cdot (POWDLY + (N_{filt} - 1) \cdot SETDLY + (21N_{filt} + 1) \cdot T_{osc})$$

- T_{I2C} is the period of the I2C clock SCL
- $N_{filt} = \{1, 3, 5, 7\}$ based on the order defined for the filter FILT
- $N_{chan} = \{1, 2, 3, 4, 5\}$ based on the number of channels defined in RegChanMsk
- POWDLY = 0.5us to 18.19ms, settling time as defined in RegTS0
- SETDLY = 0.5us to 18.19ms, settling time when filtering as defined in RegTS2
- T_{osc} is the period of the internal oscillator FOSCH

Some examples of maximum throughputs achievable with an I2C running at 400kHz are given below.

Nchan	Nfilt	POWDLY [us]	SETDLY [us]	Tconv [us]	Tcom [us]	Total [us]	CR [kcps]	ECR [kcps]	SR [ksps]	ESR [ksps]
2	1	0.5	0.5	51.7	100	151.7	6.6	13.2	6.6	13.2
2	3	35.5	0.5	170.6	100	270.6	3.7	7.4	11.1	22.2
2	5	2.2	0.5	152.8	100	252.8	4	8	20	40
4	3	35.5	0.5	315.0	200	515	1.9	7.6	5.7	22.8

Table 8 – Maximum Throughputs Examples

- CR = Coordinate Rate
- ECR = Equivalent Coordinate Rate = $CR \times N_{chan}$
- SR = Sampling Rate = $CR \times N_{filt}$
- ESR = Equivalent Sampling Rate = $SR \times N_{chan} = CR \times N_{filt} \times N_{chan}$

For proper operation, the TOUCHRATE parameter should not exceed the theoretical maximum throughput CR.

5 PROXIMITY SENSING INTERFACE (SX8674/76)

5.1 Introduction

The purpose of the proximity sensing interface is to detect when a conductive object (usually a body part i.e. finger, palm, face, etc) is in the proximity of the system. This is commonly used in power-sensitive mobile applications to turn the screen's LCD ON/OFF depending on user's finger/palm/face proximity.

The chip's proximity sensing interface is based on capacitive sensing technology and shares the ADC with the touchscreen interface (Cf §5.4.2). An overview is given in figure below.

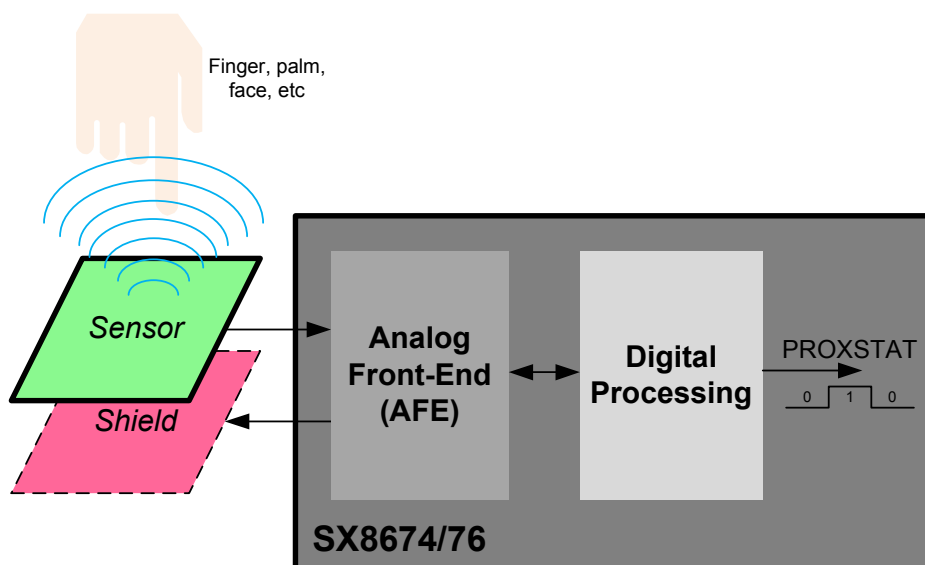


Figure 27 – Proximity Sensing Interface Overview

- ❖ The sensor can be the top layer of the touchscreen or a simple copper area on the PCB (programmable in PROXSENSORCON). Its capacitance (to ground) will vary when a conductive object is moving in its proximity.
- ❖ The optional shield can be the bottom layer of the touchscreen or a simple copper area on the PCB (programmable in PROXSHIELDCON) below/under/around the sensor. It is used to protect the sensor against potential surrounding noise sources and improve its global performance. It also brings directivity to the sensing, for example sensing objects approaching from top only.
- ❖ The analog front-end (AFE) performs the raw sensor's capacitance measurement and converts it into a 12 bit digital code. It also controls the shield. See §5.2 for more details.
- ❖ The digital processing block computes the raw capacitance measurement from the AFE and extracts a binary information PROXSTAT corresponding to the proximity status, i.e. object is "Far" or "Close". It also triggers AFE operations (compensation, etc). See §5.3 for more details.

To save power since the proximity event is slow by nature, the block will be waken-up regularly at every programmed scan period (PROXSCANPERIOD) to sense and then process a new proximity sample. The block will be in idle mode most of the time. This is illustrated in figure below

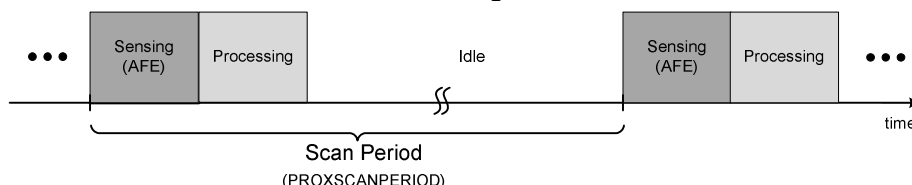


Figure 28 – Proximity Sensing Sequencing

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5.2 Analog Front-End (AFE)

5.2.1 Capacitive Sensing Basics

Capacitive sensing is the art of measuring a small variation of capacitance in a noisy environment. As mentioned above, the chip's proximity sensing interface is based on capacitive sensing technology. In order to illustrate some of the user choices and compromises required when using this technology it is useful to understand its basic principles.

To illustrate the principle of capacitive sensing we will use the simplest implementation where the sensor is a copper plate on a PCB but the exact same principles apply if the sensor is the touchscreen's top plate.

The figure below shows a cross-section and top view of a typical capacitive sensing implementation. The sensor connected to the chip is a simple copper area on top layer of the PCB. It is usually surrounded (shielded) by ground for noise immunity (shield function) but also indirectly couples via the grounds areas of the rest of the system (PCB ground traces/planes, housing, etc). For obvious reasons (design, isolation, robustness ...) the sensor is stacked behind an overlay which is usually integrated in the housing of the complete system. When the touchscreen is used for sensing the overlay corresponds to the thin and flexible protection film covering the top panel.

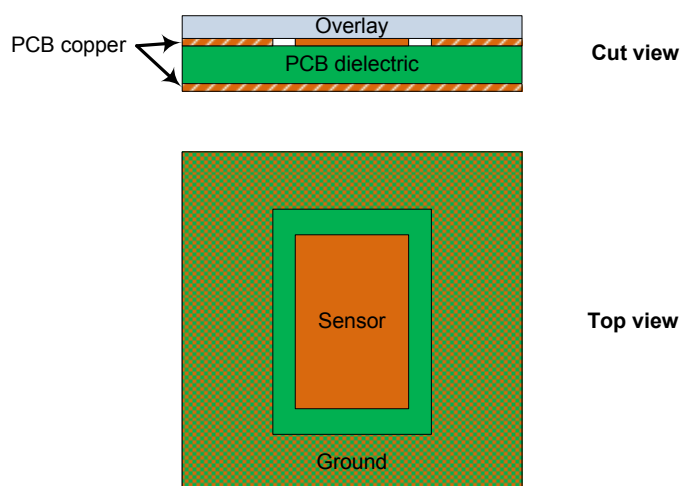


Figure 29 – Typical Capacitive Sensing Implementation

When the conductive object to be detected (finger/palm/face, etc) is not present, the sensor only sees an inherent capacitance value C_{Env} created by its electrical field's interaction with the environment, in particular with ground areas.

When the conductive object (finger/palm/face, etc) approaches, the electrical field around the sensor will be modified and the total capacitance seen by the sensor increased by the user capacitance C_{User} . This phenomenon is illustrated in the figure below.

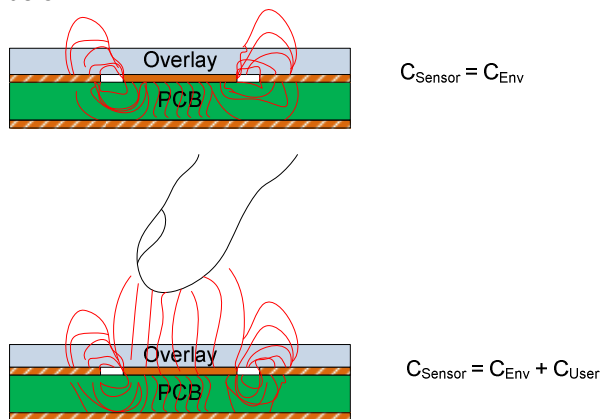


Figure 30 – Proximity Effect on Electrical Field and Sensor Capacitance

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The challenge of capacitive sensing is to detect this relatively small variation of C_{Sensor} (C_{User} usually contributes for a few percents only) and differentiate it from environmental noise (C_{Env} also slowly varies together with the environment characteristics like temperature, etc). For this purpose, the chip integrates an auto offset compensation mechanism which dynamically monitors and removes the C_{Env} component to extract and process C_{User} only. See §5.2.5 for more details.

In first order, C_{User} can be estimated by the formula below:

$$C_{\text{User}} = \frac{\epsilon_0 \cdot \epsilon_r \cdot A}{d}$$

A is the common area between the two electrodes hence the common area between the user's finger/palm/face and the sensor.

d is the distance between the two electrodes hence the proximity distance between the user and the system.

ϵ_0 is the free space permittivity and is equal to $8.85 \cdot 10^{-12}$ F/m (constant)

ϵ_r is the dielectric relative permittivity.

When performing proximity sensing the dielectric relative permittivity is roughly equal to that of the air as the overlay is relatively thin compared to the detection distance targeted. Typical permittivity of some common materials is given in the table below.

Material	Typical ϵ_r
Glass	8
FR4	5
Acrylic Glass	3
Wood	2
Air	1

From the discussions above we can conclude that the most robust and efficient design will be the one that minimizes C_{Env} value and variations while improving C_{User} .

5.2.2 AFE Block Diagram

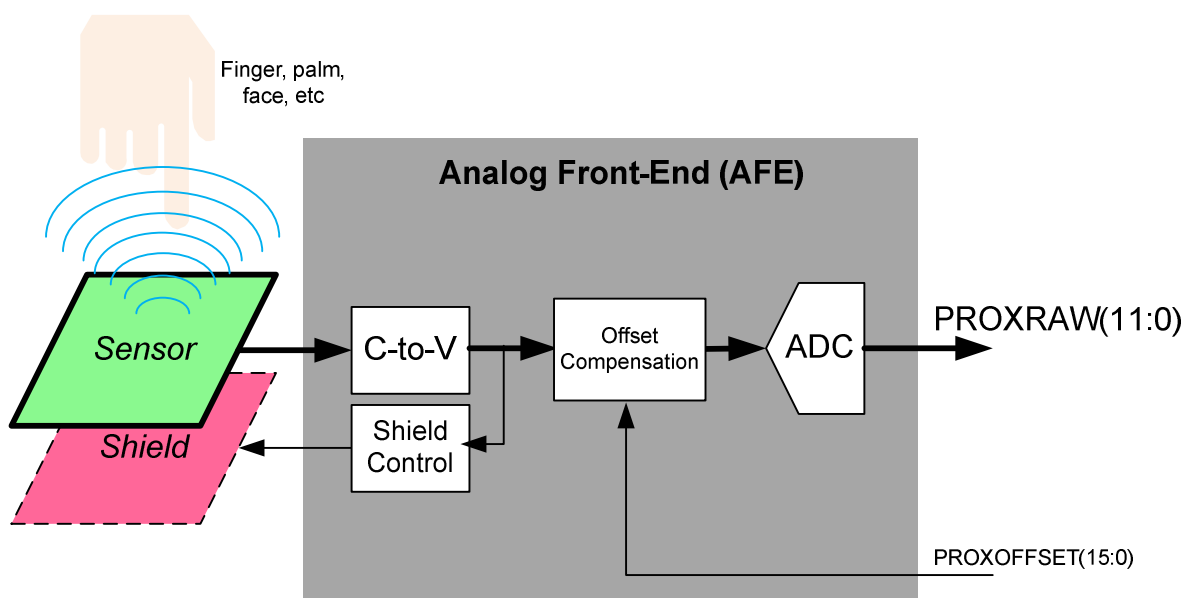


Figure 31 – Analog Front-End Block Diagram

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5.2.3 Capacitance-to-Voltage Conversion (C-to-V)

PROXSENSORCON defines which pin will act as the sensor during proximity sensing operations. In the typical case, the touchscreen top layer is used as the sensor (exact pin/electrode depends on screen type/structure). Else, the sensor can also be “external”, i.e. connected to AUX2.

The sensitivity of the interface is defined by PROXSENSITIVITY; for obvious power consumption reasons it is recommended to set it as low as possible.

As a last resort and only if the sensor is “external”, PROXBOOST can be set to allow higher sensitivity if needed.

PROXFREQ defines the operating frequency of the interface and should be set as high as possible for power consumption reasons.

If needed, PROXHIGHIM enables a high noise immunity mode at the expense of increased power consumption.

5.2.4 Shield Control

PROXSHIELDCON defines which pin will act as the shield during proximity sensing operations. In the typical case, the shield will usually be the touchscreen bottom layer (exact pin/electrode depends on screen type/structure). Else, the shield can also be “external”, ie a simple copper area on the PCB connected to AUX3.

5.2.5 Offset Compensation

Offset compensation consists in performing a one time measurement of C_{Env} and subtracting it to the total capacitance C_{Sensor} in order to feed the ADC with the closest contribution of C_{User} only.

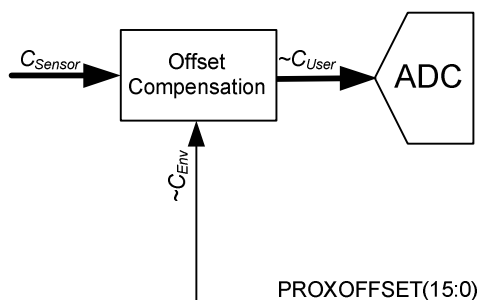


Figure 32 – Offset Compensation Block Diagram

The ADC input C_{User} is the total capacitance C_{Sensor} to which C_{Env} is subtracted.

There are five possible compensation sources which are illustrated in the figure below. When set to 1 by any of these sources, PROXCOMPSTAT will only be reset once the compensation is completed.

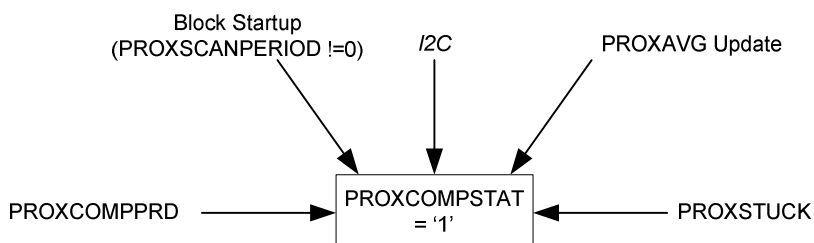


Figure 33 – Compensation Request Sources

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- **Block startup:** a compensation is automatically requested when the proximity sensing is enabled via PROXSCANPERIOD.
- **I2C:** a compensation can be manually requested anytime by the host through I2C interface.
- **PROXAVG update:** a compensation can be automatically requested if it is detected that C_{Env} has drifted beyond a set level since the last compensation.
- **PROXCOMPPRD:** a compensation can be automatically requested at a predefined rate programmed by the host.
- **PROXSTUCK:** a compensation can be automatically requested if it is detected that the proximity "Close" state is lasting abnormally long.

Please note that the compensation request flag can be set anytime but the compensation itself is always done at the beginning of a scan period to keep all parameters coherent (PROXRAW, PROXAVG, PROXDIFF), see §5.3.2.

5.2.6 Analog-to-Digital Conversion (ADC)

A 12-bit ADC is used to convert the capacitance information into a digital 12-bit word PROXRAW. The ADC is shared with the touchscreen interface using time multiplexing (see §5.4.2 for more details).

5.3 Digital Processing

5.3.1 Overview

The main purpose of the digital processing block is to convert the raw capacitance information coming from the AFE (PROXRAW) into a robust and reliable digital flag (PROXSTAT) indicating if the user's finger/hand/head is close to the proximity sensor.

The offset compensation performed in the AFE is a one time measurement. However, the environment capacitance C_{Env} may vary with time (temperature, nearby objects, etc). Hence, in order to get the best estimation of C_{User} (PROXDIFF) it is needed to dynamically track and subtract C_{Env} variations. This is performed by filtering PROXUSEFUL to extract its slow variations (PROXAVG).

PROXDIFF is then compared to user programmable threshold to extract PROXSTAT flag.

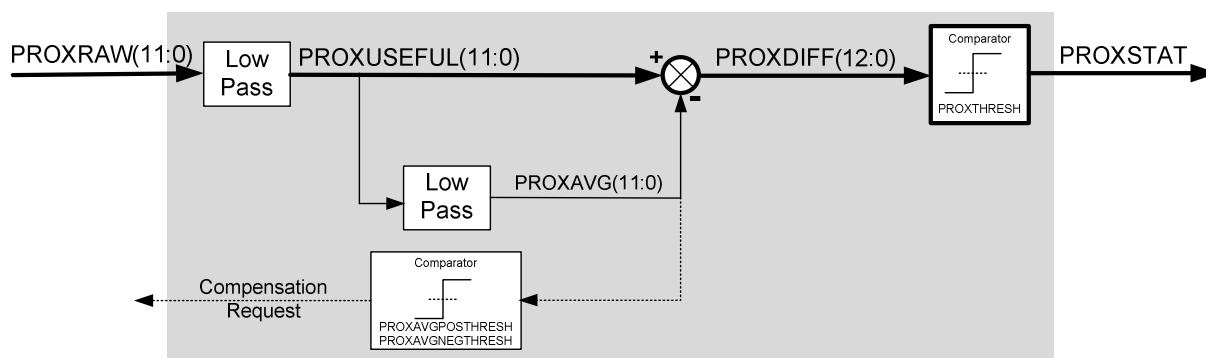


Figure 34 – Digital Processing Block Diagram

Digital processing sequencing is illustrated in figure below. At every scan period wake-up (defined by PROXSCANPERIOD), the block updates sequentially PROXRAW, PROXUSEFUL, PROXAVG, PROXDIFF and PROXSTAT before going back to Idle mode.

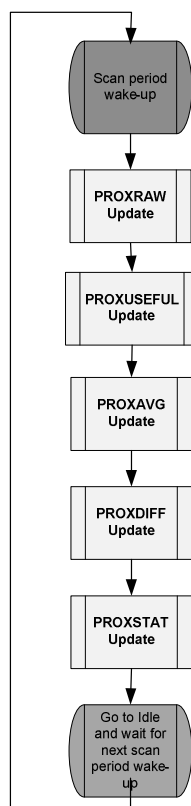


Figure 35 – Digital Processing Sequencing

Digital processing block also updates CONVSTAT (set during proximity operations) and PROXCOMPSTAT (set when compensation is currently pending execution or competition)

5.3.2 PROXRAW Update

PROXRAW update consists mainly in starting the AFE and waiting for the new PROXRAW value to be ready. If a compensation was pending it is performed first.

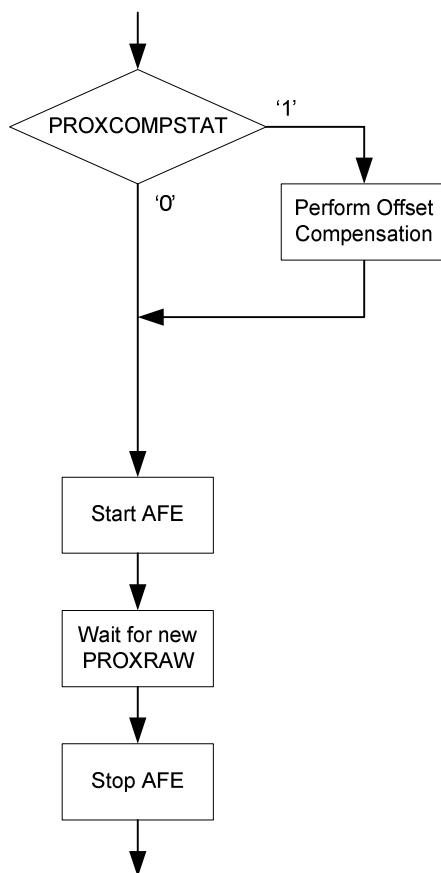


Figure 36 – ProxRaw Update

5.3.3 PROXUSEFUL Update

PROXUSEFUL update consists in filtering PROXRAW upfront to remove its potential high frequencies components(system noise, interferer, etc) and extract only user activity (few Hz max) and slow environment changes.

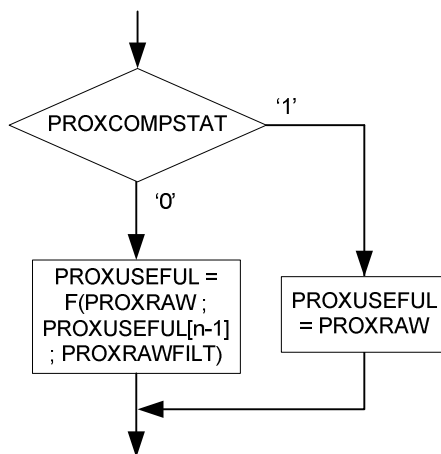


Figure 37 – PROXUSEFUL Update

$$F(\text{PROXRAW} ; \text{PROXUSEFUL}[n-1] ; \text{PROXRAWFILT}) = (1 - \text{PROXRAWFILT}).\text{PROXRAW} + \text{PROXRAWFILT}.\text{PROXUSEFUL}[n-1]$$

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5.3.4 PROXAVG Update

PROXAVG update consists in averaging PROXUSEFUL to ignore its “fast” variations (i.e. user finger/palm/hand) and extract only the very slow variations of environment capacitance C_{Env} .

One can program positive and negative debounced thresholds (PROXAVGPOSTHRESH/PROXAVGPOSDEB and PROXAVGNEGTHRESH/PROXAVGNEGDEB) within which PROXAVG can vary without triggering compensation (ie small acceptable environment drift).

Large positive values of PROXUSEFUL are considered as normal (user finger/hand/head) but large negative values are considered abnormal and should be compensated quickly. For this purpose, the averaging filter coefficient can be set independently for positive and negative variations via PROXAVGPOSFILT and PROXAVGNEGFILT. Typically we have $PROXAVGPOSFILT > PROXAVGNEGFILT$ to filter out (abnormal) negative events faster.

To prevent PROXAVG to be “corrupted” by user activity (should only reflect environmental changes) it is freezes when proximity is detected.

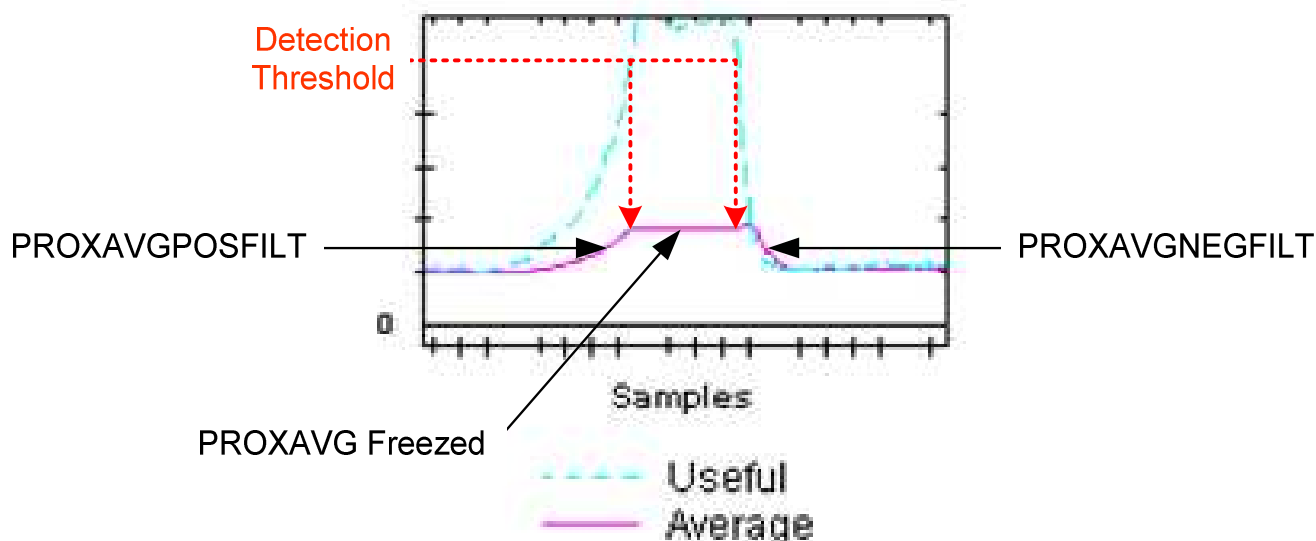


Figure 38 – ProxAvg vs Proximity Event

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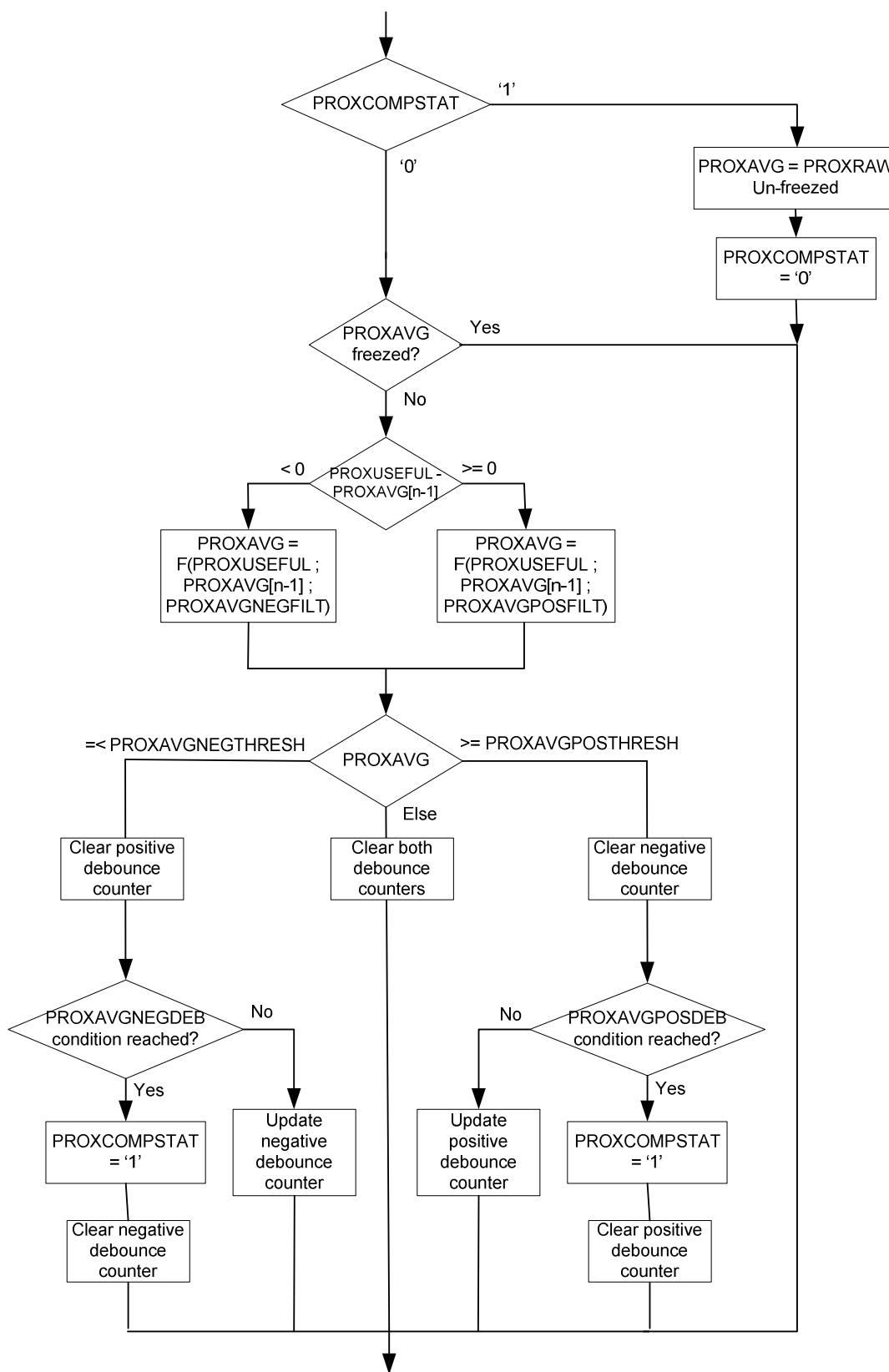


Figure 39 – ProxAvg Update

$$F(\text{PROXUSEFUL} ; \text{PROXAVG}[n-1] ; \text{PROXAVGxxxFILT}) = (1 - \text{PROXAVGxxxFILT}) \cdot \text{PROXUSEFUL} + \text{PROXAVGxxxFILT} \cdot \text{PROXAVG}[n-1]$$

xxx = POS or NEG

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5.3.5 PROXDIFF Update

PROXDIFF update consists in the complementary operation i.e. subtracting PROXAVG to PROXUSEFUL to ignore slow capacitances variations (C_{Env}) and extract only the user related variations i.e. C_{User} .

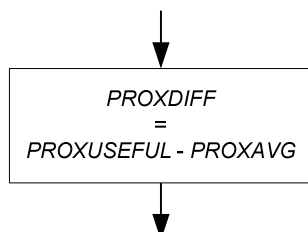


Figure 40 – ProxDiff Update

5.3.6 PROXSTAT Update

PROXSTAT update consists in taking PROXDIFF information (C_{User}), comparing it with a user programmable threshold PROXTHRESH and finally updating PROXSTAT accordingly. When PROXSTAT=1, PROXAVG is frozen to prevent the user proximity signal averaging and hence absorbed into C_{Env} .

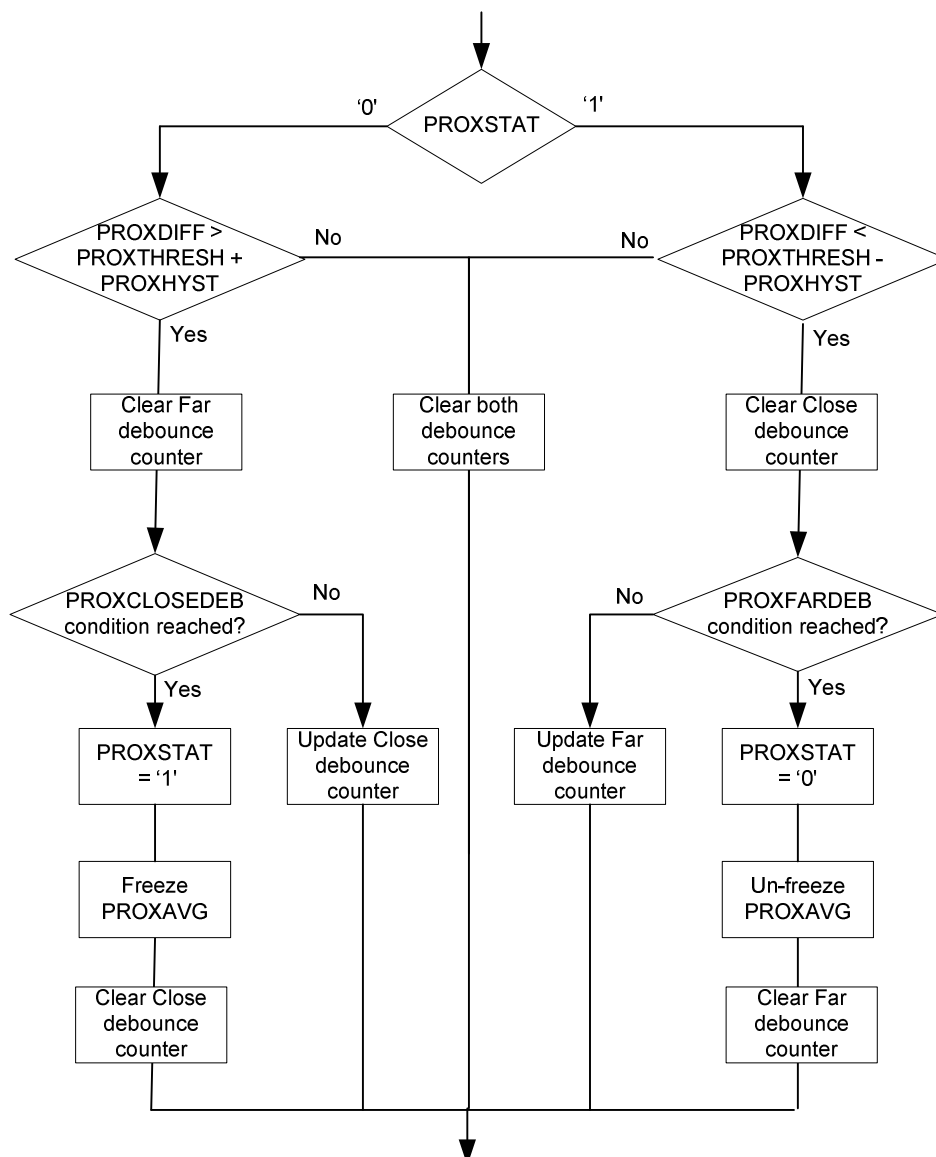


Figure 41 – PROXSTAT Update

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5.4 Host Operation

5.4.1 General Description

If PROXIRQSEL = 0, an interrupt can be triggered when the user is detected to be close, detected to be far, or both (PROXCLOSEIRQEN, PROXFARIRQEN).

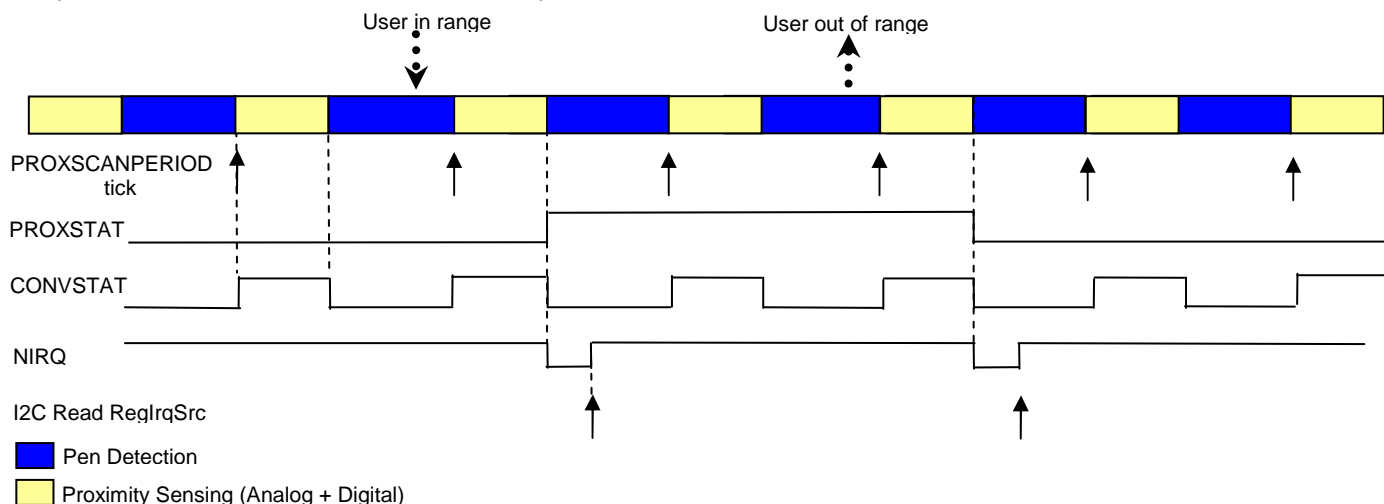


Figure 42 – Proximity Sensing Host Operation (Pen Trigger Mode ; RegLrqMsk[6:4] = 110 ; PROXIRQSEL = 0)

If PROXIRQSEL = 1, instead of the proximity “Far” state, an interrupt can be triggered at the end of each proximity sensing operation indicating to the host when the proximity sensing block is running (PROXCONVDONEIRQEN). This may be used by the host to synchronize noisy system operations or to read PROXRW, PROXUSEFUL, PROXAVG, PROXDIF for monitoring purposes.

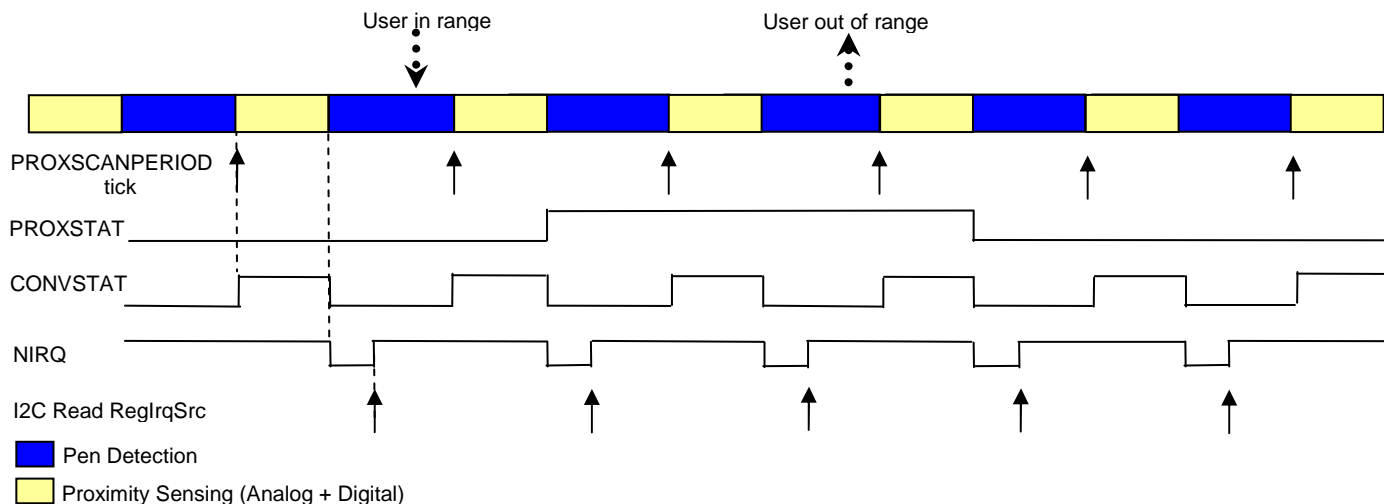


Figure 43 – Proximity Sensing Host Operation (Pen Trigger Mode ; RegLrqMsk[6:4] = 010 ; PROXIRQSEL = 1)

In both cases above, an interrupt can also be triggered at the end of compensation (PROXCOMPDONEEN).

5.4.2 Proximity Sensing vs Touch Operations

As previously mentioned, touch and proximity operations share the same ADC and hence the chip implements time multiplexing between these two types of operations. Also, proximity sensing doesn't need to be performed while pen is down (not needed as host knows already something touches the screen).

In all operating modes, if PROXSCANPERIOD = 0, no proximity operation is performed (i.e. §4.7). The following hence assumes PROXSCANPERIOD != 0. For simplicity we also assume that NIRQ is only used for reporting touch operations i.e. RegLrqMsk[6:4] = 000 (PROXSTAT mapped to AUX pin, or polled via I2C).

In MAN mode, a CONVERT command (if not preceded by a SELECT command) will perform a proximity sensing operation before the touchscreen operation, whatever the pen status. Hence please note that if the

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touchscreen is used as the proximity sensor and is being touched when the conversion is performed, the proximity measurement result may be incorrect.

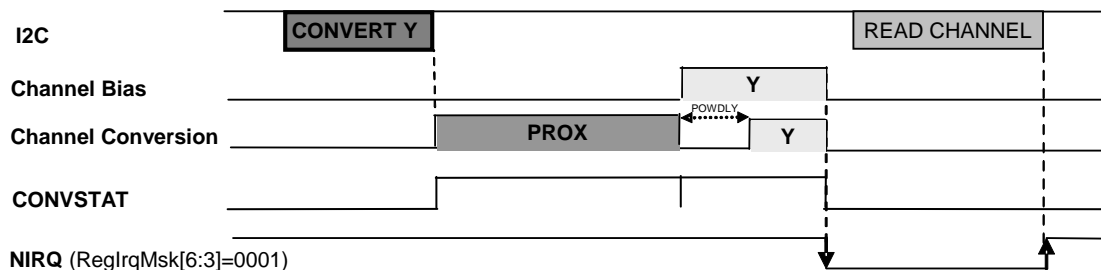


Figure 44 – Manual Mode – CONVERT Command (CHAN = Y ; PROXSCANPERIOD != 0; Pen down)

If the screen is not touched, only the proximity sensing operation is performed.

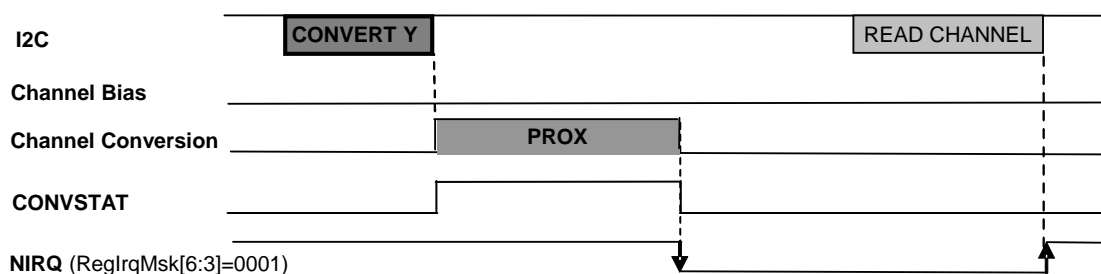


Figure 45 – Manual Mode – CONVERT Command (CHAN = Y ; PROXSCANPERIOD != 0, Pen up)

In PENDET and PENTRG mode, a proximity sensing operation will be performed regularly as defined in PROXSCANPERIOD, but only if pen is not detected.

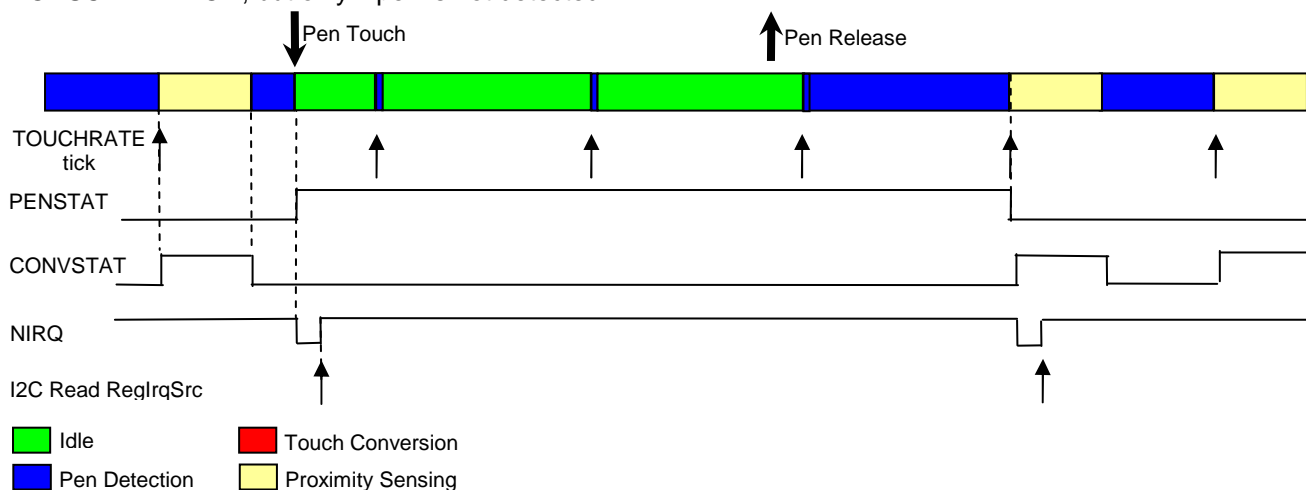


Figure 46 – Pen Detect Mode (RegIrqMsk[6:2] = 00011 ; PROXSCANPERIOD = 001 ie 1/TOUCHRATE)



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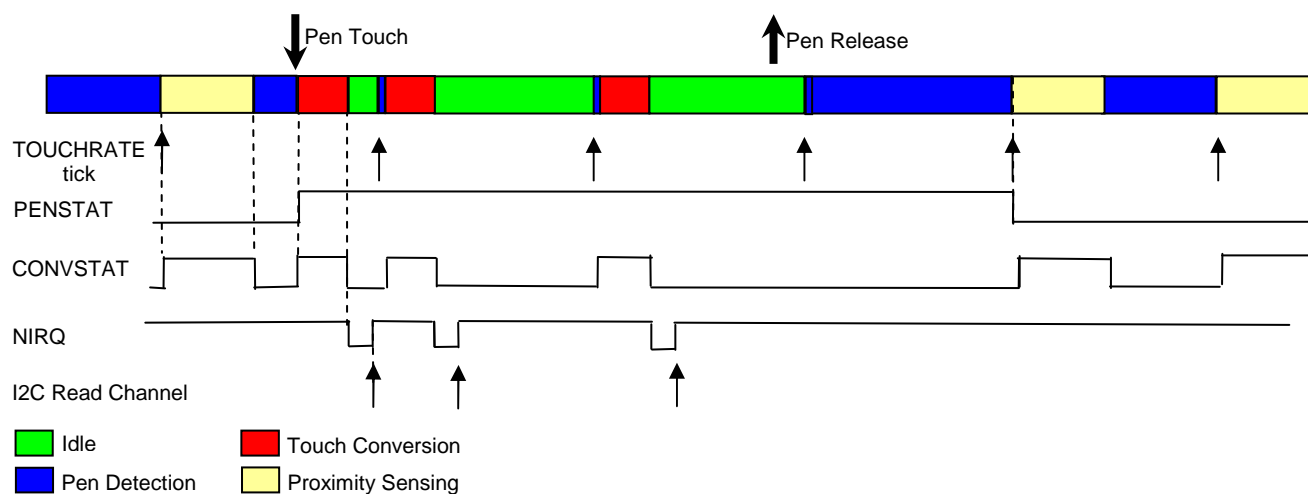


Figure 47 – Pen Trigger Mode (RegIrqMsk[6:2] = 00010 ; PROXSCANPERIOD = 001 ie 1/TOUCHRATE)

5.4.3 Minimum Scan Period (i.e. PROXSCANPERIOD)

Similarly to touch operations (Cf. §4.7.5), if PROXSCANPERIOD is too short for proximity sensing operations to be completed, the rate tick(s) affected are ignored until operations are completed and the following tick is taken into account for the next planned operation.

Please note that compensation lasts about ~16 times longer than a normal proximity sensing operation.

6 HAPTICS INTERFACE (SX8674/75)

6.1 Introduction

Haptics technology is commonly used in systems which include a touchscreen interface. Its purpose is to provide tactile feedback to the user to acknowledge a touch event hence improving greatly the robustness of the system and user comfort and perception.

The on-chip haptics interface is designed to drive two common actuator types: Eccentric Rotating Mass (ERM) and Linear Resonant Actuator (LRA). This is performed without any external component due to fully embedded analog processing and with very limited host interaction due to the embedded digital processing block.

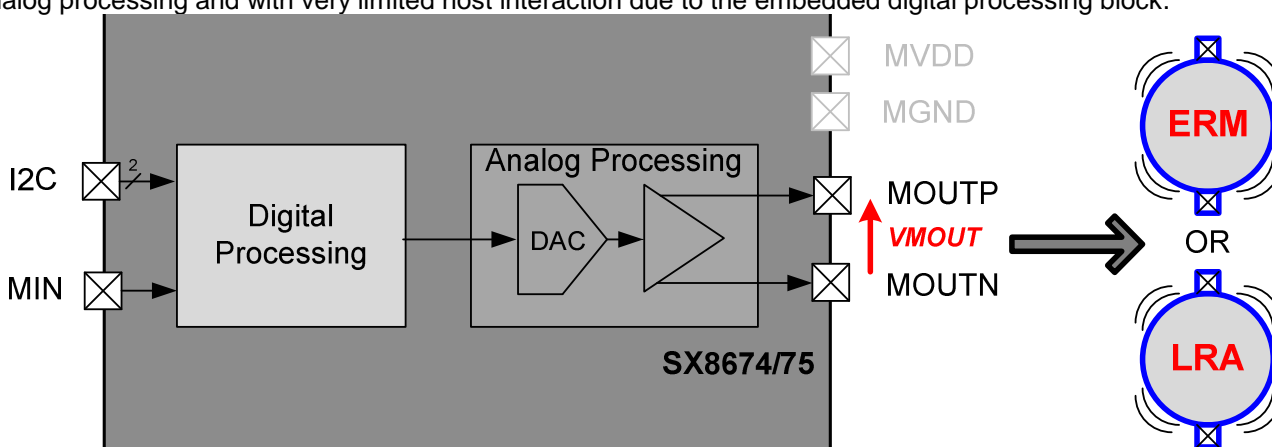


Figure 48 – Haptics Interface Overview

The host configures drive parameters from the I2C port according to the particular haptics load to be used. The haptics drive level is then controlled in real time by either of two methods: by a dedicated digital pin, MIN, which accepts a pulse-width-modulated (PWM) digital signal; or by writing the desired output level directly to a register via the I2C interface.

This digital information is filtered to prevent fast transitions and hence high current spikes (HAPTBW), converted into the analog domain by an 8-bit DAC, and finally amplified (HAPTAIN) to provide a differential signal between MOUTP and MOUTN pins which can be directly connected to the motor thanks to their high drive current capability.

For better isolation from the rest of the chip, the haptics interface analog block has its own power supply pins MVDD and MGND.

The haptics interface is enabled when HAPTTYPEEN != 0.

6.2 ERM Load

6.2.1 Introduction

An ERM is a DC motor with an off-balance load to create a vibration. Speed and direction are controlled by the applied voltage. The ERM load is selected when HAPTTYPEEN = 10.

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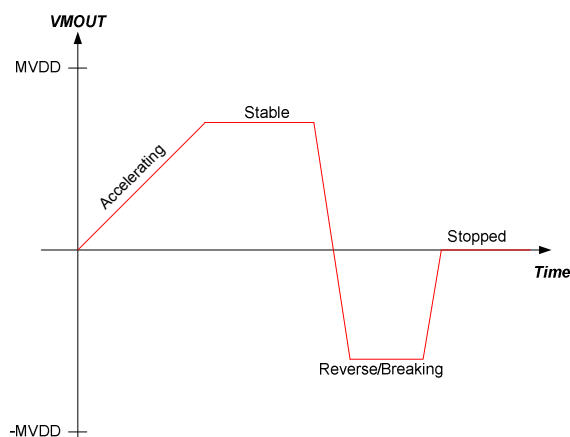


Figure 49 – ERM Drive Signal Example

If AmplitudeCode is within HAPTSQUELCH range (for more than 512/MIN_Freq in PWM mode, for more than 512/FOSCL in I2C mode):

$$VMOUT = 0V$$

Else:

$$VMOUT(V) = (AmplitudeCode / 127) \times 1.135 \times HAPTAIN$$

AmplitudeCode (signed) is defined differently depending on the mode selected (PWM or I2C), see below.

Please note that whatever setting, VMOUT is physically limited to [MVDD;-MVDD], i.e. saturation effect.

6.2.2 PWM Mode

PWM mode is selected when HAPTMODE = 0.

In this mode, AmplitudeCode is extracted/updated at each MIN period from MIN_DutyCycle:

- MIN_DutyCycle ≈ 0% => AmplitudeCode = -127
- ...
- MIN_DutyCycle = 49.6% => AmplitudeCode = -1
- MIN_DutyCycle = 50% => AmplitudeCode = 0
- MIN_DutyCycle = 50.4% => AmplitudeCode = +1
- ...
- MIN_DutyCycle ≈ 100% => AmplitudeCode = +127

6.2.3 I2C Mode

I2C mode is selected when HAPTMODE = 1.

In this mode, AmplitudeCode = HAPTAMP (signed, internally sampled at FOSCL). MIN is not used and should be grounded. HAPTRANGE must be set to 1.

6.3 LRA Load

6.3.1 Introduction

An LRA is a spring and mass with an electro-magnetic coil to move the mass. It is operated by applying an AC signal at its resonant frequency (typ. ~175 Hz). Like pushing a swing at its resonance, it doesn't need much energy to keep it going, so drive current requirements are much lower than for ERMs. LRAs have moderately high Q factors so that the drive frequency must match the resonant frequency within a few Hz to get optimum amplitude.

LRA load is selected when HAPTTYPEEN = 01.

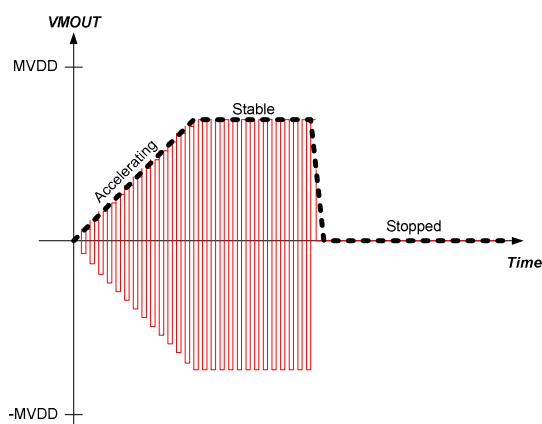


Figure 50 – LRA Drive Signal Example

The carrier frequency of VMOUT_Freq is defined as following:

$$\begin{aligned} \text{VMOUT_Freq(Hz)} &= (\text{MIN_Freq} / \text{HAPTRANGE}) && \text{(PWM mode)} \\ &\text{OR} \\ \text{VMOUT_Freq(Hz)} &= (\text{MIN_Freq} / \text{HAPTRANGE}) / (\text{HAPTTIMER} + 1) && \text{(I2C mode)} \end{aligned}$$

If AmplitudeCode is within HAPTSQUELCH range (for more than 512/VMOUT_Freq):

$$\text{VMOUT_Envelope} = 0V$$

Else:

$$\text{VMOUT_Envelope(V)} = (\text{AmplitudeCode} / 127) \times 1.135 \times \text{HAPTGAIN}$$

AmplitudeCode (signed) is defined differently depending on the mode selected (PWM or I2C), see below.

Please note that whatever setting, VMOUT is physically limited to [MVDD;-MVDD], ie saturation effect.

6.3.2 PWM Mode

PWM mode is selected when HAPTMODE = 0.

In this mode, AmplitudeCode is extracted/updated at each MIN period from MIN_DutyCycle:

- MIN_DutyCycle ≈ 0% => AmplitudeCode = -127
- ...
- MIN_DutyCycle = 49.6% => AmplitudeCode = -1
- MIN_DutyCycle = 50% => AmplitudeCode = 0
- MIN_DutyCycle = 50.4% => AmplitudeCode = +1
- ...
- MIN_DutyCycle ≈ 100% => AmplitudeCode = +127

6.3.3 I2C Mode

I2C mode is selected when HAPTMODE = 1.

In this mode, AmplitudeCode = HAPTAMP (signed, internally sampled at MIN_Freq). MIN is still used to extract VMOUT carrier frequency.

6.4 Short-Circuit Protection

The haptics interface integrates a short-circuit protection circuit which detects when MIDD is abnormally high i.e. above ISHORT. Under a short-circuit event (HAPTSHORTSTAT=1) the haptics block will stop operation (MOUTN & MOUTP grounded). When the short-circuit is removed the haptics operations will resume normally.

7 TEMPERATURE SENSOR

The chip includes a temperature sensor which monitors the chip's junction temperature. Its purpose is to provide over-temperature information to the host and if needed automatically shutdown chip operation for thermal protection.

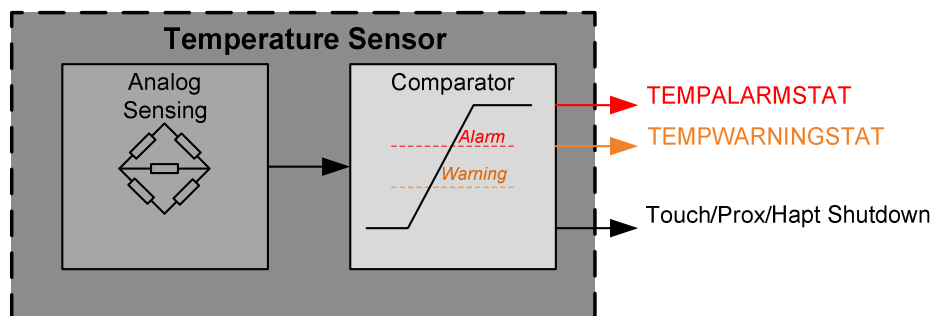


Figure 51 – Temperature Sensor Overview

If TEMPALWAYSON = 0 (default), the temperature sensor will perform measurements only if the chip is active i.e. touchscreen interface running (Op. Mode != MAN), proximity sensing interface enabled (PROXSCANPERIOD != 0) or haptics interface enabled (HAPTTYPEEN != 00). The temperature sensor will perform a measurement every ~32 ms (1024/FOSC) but not during ADC conversions (temperature sensing delayed accordingly).

If TEMPALWAYSON = 1, the temperature sensor will always perform a measurement every ~32 ms independently from chip activity (i.e. also when the chip is inactive and during ADC conversions).

Each measurement is compared with two internally hard-coded thresholds:

- Warning level: typ. 120°C (TWRNG).
- Alarm level: typ. 155°C (TALRM)

Each of these thresholds is associated to a status flag (TEMPWARNINGSTAT, TEMPALARMSTAT) which edges can be mapped to generate an interrupt to the host.

Additionally, during an alarm situation (i.e. temperature > alarm level) all chip operations (i.e. touchscreen, proximity, haptics) are automatically shutdown until the temperature goes below the alarm level.

After a shutdown event all stored conversion data are thrown away. Cycling operations (TOUCHRATE > 0) will resume from the start (i.e. if a 4 channel conversion is stopped during the 3rd channel conversion, when resuming, the 4 channels will be converted again). If the user was running some manual operation (SELECT, CONVERT), the corresponding command will have to be re-issued. The haptics operations will resume directly.



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8 INTERRUPT (NIRQ)

8.1 Introduction

The purpose of the NIRQ pin is to indicate to the host (via a falling edge) when any of the events considered being time-critical has occurred. Non time-critical events can be monitored via I2C by reading regularly the relevant status bits.

8.2 Registers Overview

8.2.1 RegIrqMsk

This register allows the host to decide which interrupt sources he wants to monitor via the NIRQ signal. Please note that a reset event will always trigger NIRQ falling edge whatever RegIrqMsk (Cf §10)

8.2.2 RegIrqSrc

This register indicates to the host which of the interrupt sources triggered the NIRQ signal. More than one bit can be set if several events occurred before host reads the register.

If bit 3 is OFF, reading the register will clear it together with releasing NIRQ signal. Else, if bit 3 is ON and we are in MAN or PENTRG mode, both register and NIRQ will be cleared only once all channel data have been read. All ADC related operations (touch conversion, proximity conversion, pen detection) are stopped as long as all channel data have not been read.

Bits which RegIrqMsk corresponding bits are set to 0 (ie source not monitored) will always read 0 even if the event actually occurred.

8.2.3 RegStat

This register regroups all status information of the chip and is used by all interrupt sources to detect the relevant events. For each bit, if the relevant block is ON its value is constantly updated, else it is set to 0. This register update is completely independent from RegIrqMsk.

8.3 Host Procedure

- Configure the different blocks parameters (TS, Proximity, etc)
- Program RegIrqMsk to start monitoring what is considered to be "time-critical" events
- Enable the blocks to start RegStat update and hence NIRQ process.
- Each time NIRQ falling edge occurs, read RegIrqSrc to know which "time-critical" event occurred (+ read channel data if relevant)
- In addition, RegStat can be read anytime to get the whole picture including also what is considered to be "non time-critical" information.



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9 AUXILIARY PINS (AUX1/AUX2/AUX3)

The chip has three auxiliary pins which can be used:

1. By the touchscreen interface when using a 5-wire touchscreen (WIPER=AUX1)
2. By the proximity sensing interface (PROXSENSORCON and PROXSHIELDCON) to use an external sensor and/or shield instead of the touchscreen's plates
3. By the host (RegAux0-1) to monitor any RegStat and/or RegIrqSrc bits in real time without having to use NIRQ or perform I2C polling.

10 RESET

10.1 Hardware (POR and NRST)

The chip generates its own power on reset (POR) signal after a power supply is connected to the VDD pin. NRST input pin can be used to reset the chip anytime, it must be connected to VDD (or greater) either directly (if not used), or via a resistor.

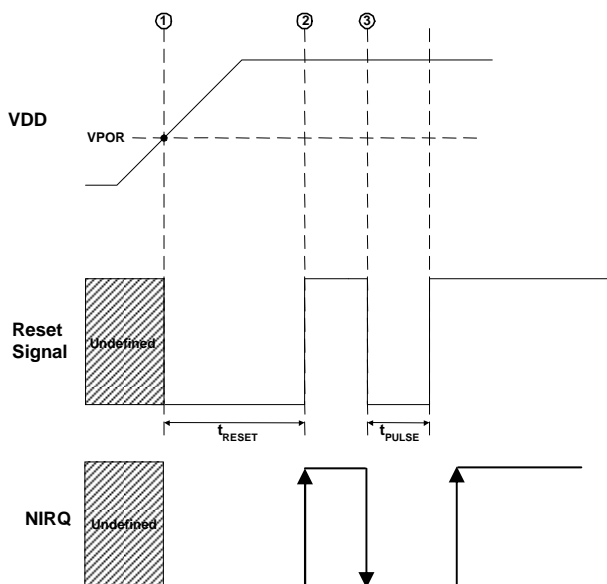


Figure 52 – Hardware Reset Conditions

1. Device behavior is undefined until VDD rises above V_{POR} , at which point internal reset procedure is started and NIRQ is kept low.
2. After t_{RESET} , the reset procedure is completed and NIRQ is released high.
3. In operation, the chip may be reset at anytime by an external device driving NRST low for t_{PULSE} or longer. NIRQ will go low during the reset phase and chip can be accessed normally again after NIRQ rising edge. Additionally bit RESETSTAT will be set (cleared when reading RegStat)

10.2 Software (RegReset)

Writing 0xDE to RegReset register will reset the chip and all registers to their default values. NIRQ will go low during the reset phase and chip can be accessed normally again after NIRQ rising edge. Additionally bit RESETSTAT will be set (cleared when reading RegStat).

10.3 ESD Event (RESETSTAT)

In case of ESD event, the chip can reset to protect its internal circuitry. NIRQ will go low during the reset phase and chip can be accessed normally again after NIRQ rising edge. Additionally bit RESETSTAT will be set (cleared when reading RegStat).

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11 I2C INTERFACE

11.1 Introduction

The chip is a read-write slave-mode I2C device and complies with the Philips I2C standard Version 2.1 dated January, 2000. The chip has a few user-accessible internal 8-bits registers to set the various parameters of operation (Cf. §12 for detailed configuration registers description). The I2C interface has been designed for program flexibility, in that once the slave address has been sent to the chip enabling it to be a slave transmitter/receiver, any register can be written or read independently of each other. The start and stop commands frame the data-packet and the repeat start condition is allowed if necessary.

2 lines are used to exchange data between an external master host and the slave device:

- **SCL** : Serial **C**lock
- **SDA** : Serial **D**ata

Seven bit addressing is used and ten bit addressing is not allowed. Any general call address will be ignored by the chip. The chip is not CBUS compatible and can operate in standard mode (100kbit/s) or fast mode (400kbit/s).

11.2 I2C Address

On the QFN package an ADDR pin is made available to select between the two pre-programmed I2C addresses of the device. On the CSP package ADDR is internally connected to ground.

This is illustrated in table below.

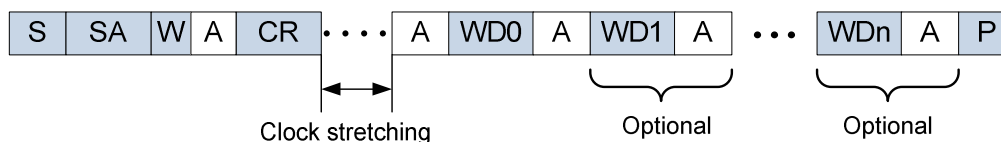
Package	ADDR	Address	Description
QFN	0	0x48 (1001000)	First I2C address
	1	0x49 (1001001)	Second I2C address
CSP	0	0x48 (1001000)	First (and unique) I2C address

Table 9 – I2C Address

Please note that upon request, a custom I2C Address can be pre-programmed by Semtech.

11.3 Write Register

The I2C write register sequence is given in figure below. After the start condition [S], the chip slave address (SA) is sent, followed by an eighth bit (W='0') indicating a write. The chip then acknowledges [A] that it is being addressed, and the host sends a CR byte consisting in '00' followed by the chip register address (RA). The chip acknowledges [A] and the host sends the appropriate data byte (WD0) to be written. Again the chip acknowledges [A]. In case the host needs to write more data, a succeeding data byte will follow (WD1), acknowledged by the slave [A]. This sequence will be repeated until the host terminates the transfer with the stop condition [P].



S: Start condition
SA: SX8654 Slave Address(6:0)
W: '0'
A: Acknowledge
CR: '00' + Register Address(5:0)
WDn: Write Data byte(7:0), 0...n
P: Stop condition



 From host to SX8654
 From SX8654 to host

Figure 53 – I2C Write Register

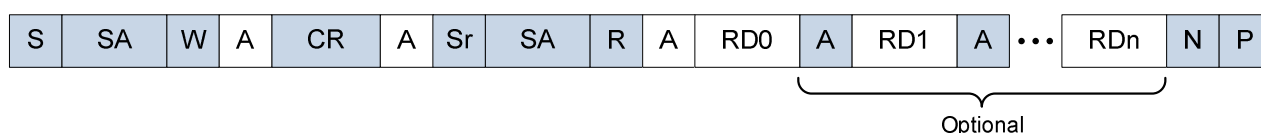
The register address increments automatically when successive data bytes (WD1...WDn) are supplied by the host.

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The correct sampling of the screen by the chip and the host I2C bus traffic are events that might occur simultaneously. The chip will synchronize these events by the use of clock stretching if that is required. The stretching occurs directly after the last received command bit (see figure above).

11.4 Read Register

The I2C read register sequence is given in figure below. After the start condition [S], the chip slave address (SA) is sent, followed by an eighth bit (W='0') indicating a write. The chip then acknowledges [A] that it is being addressed, and the host responds with a CR byte consisting in '01' followed by the register address (RA). The chip acknowledges [A] and the host sends the repeated start Condition [Sr]. Once again, the chip slave address (SA) is sent, followed by an eighth bit (R='1') indicating a read. The chip responds with an acknowledge [A] and the data byte (RD0). If the host needs to read more data it will acknowledge [A] and the chip will send the next data byte (RD1). This sequence will be repeated until the host terminates the transfer with a NACK [N] followed by a stop condition [P].



S:	Start Condition	
Sr:	Repeated Start Condition	
SA:	SX8654 Slave Address(6:0)	
W:	'0'	From host to SX8654
R:	'1'	
A:	ACKnowledge	From SX8654 to host
N:	Not ACKnowledge (terminating read stream)	
CR:	'01' + Register Address(5:0)	
RDn:	Read Data byte(7:0), 0...n	
P:	Stop Condition	

Figure 54 – I2C Read Register

The register address increments automatically when successive data bytes (RD1...RDn) are read by the host. The correct sampling of the screen by the chip and the host I2C bus traffic are events that might occur simultaneously. The chip will synchronize these events by the use of clock stretching if that is required. The stretching occurs directly after the last received command bit (see figure above).

11.5 Write Command (Touchscreen Interface)

The I2C write command sequence is given in figure below. After the start condition [S], the chip slave address (SA) is sent, followed by an eighth bit (W='0') indicating a write. The chip then acknowledges [A] that it is being addressed, and the host responds with a CR byte consisting in Command(7:0) (see table below). The chip acknowledges [A] and the host sends a stop [P].

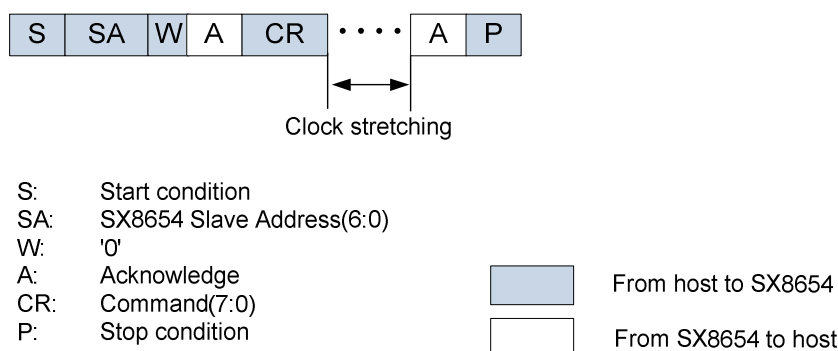


Figure 55 – I2C Write Command

The sampling of the screen by the chip and the host I2C bus traffic are events that might occur simultaneously. The chip will synchronize these events by the use of clock stretching if that is required. The stretching occurs directly after the last received command bit (see figure above).

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Command	Command(7:0)						Function		
SELECT	1	0	1	0	X	Chan(2:0)	Select and bias channel.		
CONVERT	1	0	1	1	X	Chan(2:0)	Convert channel.		
MAN	1	1	0	0	X	X	X	X	Enter manual mode.
PENDET	1	1	0	1	X	X	X	X	Enter pen detect mode.
PENTRG	1	1	1	0	X	X	X	X	Enter pen trigger mode.

Table 10 : Command Codes

Channel	Chan(2:0)			Description
X	0	0	0	X channel
Y	0	0	1	Y channel
Z1	0	1	0	First channel for pressure measurement
Z2	0	1	1	Second channel for pressure measurement
RX	1	0	1	X multitouch measurement
RY	1	1	0	Y multitouch measurement
SEQ	1	1	1	Channels enabled in RegChanMsk register

Table 11 : Channel Codes

11.6 Read Channel (Touchscreen Interface)

The I2C read channel sequence is given in figure below. After the start condition [S], the chip slave address (SA) is sent, followed by an eighth bit (R='1') indicating a read. The chip responds with an acknowledge [A] and the first data byte (RD0). The host sends an acknowledge [A] and the chip responds with the second data byte (RD1). If the host needs to read more channels, it will acknowledge [A] and the chip will send the next data bytes. This sequence will be repeated until the host terminates with a NACK [N] followed immediately by a stop [P].

The channel data that can be read is defined by RegChanMsk, or the last convert command in manual mode. A maximum number of 12 data bytes can be read when all channels (X, Y, Z1, Z2, RX, RY) are activated in RegChanMsk. The STOP [P] (if following the last valid data) releases high the NIRQ line. All ADC related operations (touch conversion, proximity conversion, pen detection) are stopped as long as all valid channel data have not been read (ie as long as NIRQ is low).

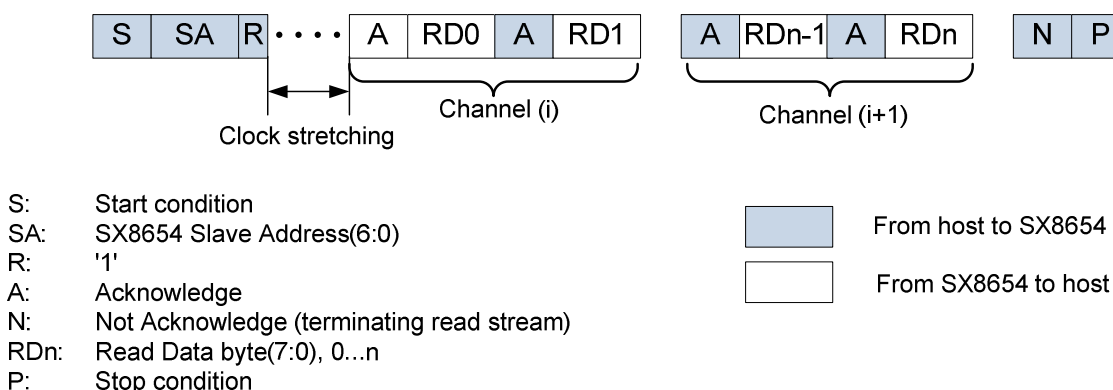


Figure 56 – I2C Read Channel

The sampling of the screen by the chip and the host I2C bus traffic are events that might occur simultaneously. The chip will synchronize these events by the use of clock stretching if that is required. The stretching occurs directly after the address and read bit have been sent for the I2C read channels command (see figure above).

The channel data is sent with the following order: X, Y, Z1, Z2, RX, RY. It is coded as described in figure below. Typical applications require only X and Y coordinates, thus only 4 bytes of data will be read in this case.



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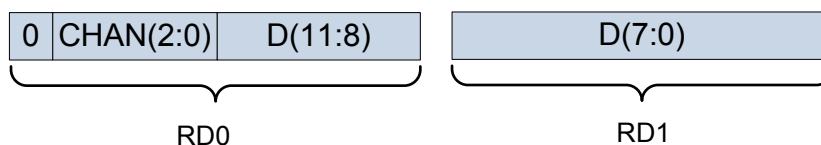


Figure 57 – Channel Data Format

The 3 bits CHAN(2:0) are defined in the previous table and show which channel data is referenced. The channel data D(11:0) is of unsigned format and corresponds to a value between 0 and 4095.

The chip will return 0xFFFF in case of invalid data; this occurs when:

- host tries to read channels which have not been converted. For example if the chip converts X and Y and the host tries to read X, Y, Z1 and Z2.
- a conversion has been done while the screen wasn't touched , i.e. pen up (not detected).



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12 REGISTERS DETAILED DESCRIPTION

Address	Name	Default	Description
0x00	RegTouch0	0x00	Touchscreen Interface
0x01	RegTouch1	0x20	
0x02	RegTouch2	0x00	
0x03	RegTouch3	0x00	
0x04	RegChanMsk	0xC0	
0x05	RegHapt0	0x00	Haptics Interface and Temperature Sensor
0x06	RegHapt1	0x00	
0x07	RegHapt2	0x00	
0x08	RegHapt3	0x80	
0x09	RegHapt4	0x00	
0x0A	RegHapt5	0x00	
0x0B	RegProx0	0x00	Proximity Sensing Interface
0x0C	RegProx1	0x00	
0x0D	RegProx2	0x00	
0x0E	RegProx3	0x00	
0x0F	RegProx4	0x00	
0x10	RegProx5	0x00	
0x11	RegProx6	0x00	
0x12	RegProx7	0x00	
0x13	RegProx8	0x00	
0x14	RegProx9	0x00	
0x15	RegProx10	0x00	
0x16	RegProx11	0x00	
0x17	RegProx12	0x00	
0x18	RegProx13	0x00	
0x19	RegProx14	0x00	
0x1A	RegProx15	0x00	
0x1B	RegProx16	0x00	
0x1C	RegProx17	0x00	
0x1D	RegProx18	0x00	
0x1E	RegProx19	0x00	
0x1F	RegProx20	0x00	
0x20	RegProx21	0x01	
0x21	RegProx22	0x00	
0x22	RegIrqMsk	0x08	Interrupt and Chip Status
0x23	RegIrqSrc	0x00	
0x24	RegStat	0x00	
0x25	RegAux0	0x00	Auxiliary Functions
0x26	RegAux1	0x00	
0x3F	RegReset	0x00	Software Reset

Table 12 : Registers Overview

NOTES:

- 1) Addresses not listed above are reserved and should not be written.
- 2) **Reserved bits should be left to their default value unless otherwise specified.**
- 3) Proximity related registers/bits do not apply to SX8675.
- 4) Haptics related registers/bits do not apply to SX8676.

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Bits	Variable	Default	Description
7:4	TOUCHRATE	0000	<p>Defines the touch coordinates acquisition rate:</p> <p>0000 : OFF. 0001 : 10 cps 0010 : 20 cps 0011 : 40 cps 0100 : 60 cps 0101 : 80 cps 0110 : 100 cps 0111 : 200 cps 1000 : 300 cps 1001 : 400 cps 1010 : 500 cps 1011 : 1 kcps 1100 : 2 kcps 1101 : 3 kcps 1110 : 4 kcps 1111 : 5 kcps</p> <p>Values above assume typical FOSCL, else vary accordingly.</p>
3:0	POWDLY	0000	<p>Defines the bias settling time for each channel's first conversion:</p> <p>0000 : 0.5 us 0001 : 1.1 us 0010 : 2.2 us 0011 : 4.4 us 0100 : 8.9 us 0101 : 17.8 us 0110 : 35.5 us 0111 : 71.0 us 1000 : 142 us 1001 : 284 us 1010 : 768 us 1011 : 1.14 ms 1100 : 2.27 ms 1101 : 4.75 ms 1110 : 9.09 ms 1111 : 18.19 ms</p> <p>Values above assume typical FOSCH, else vary accordingly.</p>

Table 13 : RegTouch0 (Addr 0x00)

Bits	Variable	Default	Description
7:5	Reserved	001	
4	TSTYPE	0	<p>Defines the type of touchscreen:</p> <p>0 : 4-wire 1 : 5-wire</p>
3:2	RPNDT	00	<p>Defines the pen detection circuit's pull-up resistor value:</p> <p>00 : 114 kOhms 01 : 228 kOhms 10 : 57 kOhms 11 : 28 kOhms</p>
1:0	FILT	00	<p>Defines the channel filtering algorithm:</p> <p>00 : OFF (Nfilt = 1) 01 : 3 sample averaging (Nfilt = 3) 10 : 5 sample averaging (Nfilt = 5) 11 : 3 sample averaging after removal of extreme values (Nfilt = 7)</p>

Table 14 : RegTouch1 (Addr 0x01)

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Bits	Variable	Default	Description
7:4	Reserved	0000	
3:0	SETDLY	0000	<p>Defines the bias settling time for each channel's subsequent conversion (i.e. when filtering is enabled):</p> <p>0000 : 0.5 us 0001 : 1.1 us 0010 : 2.2 us 0011 : 4.4 us 0100 : 8.9 us 0101 : 17.8 us 0110 : 35.5 us 0111 : 71.0 us 1000 : 142 us 1001 : 284 us 1010 : 768 us 1011 : 1.14 ms 1100 : 2.27 ms 1101 : 4.75 ms 1110 : 9.09 ms 1111 : 18.19 ms</p> <p>Values above assume typical FOSCH, else vary accordingly.</p>

Table 15 : RegTouch2 (Addr 0x02)

Bits	Variable	Default	Description
7:6	Reserved	00	
5:3	RMSELY	000	Cf. §4.5
2:0	RMSELX	000	Cf. §4.5

Table 16 : RegTouch3 (Addr 0x03)

Bits	Variable	Default	Description
7	XCONV	1	Enables X channel conversion: 0 : OFF 1 : ON
6	YCONV	1	Enables Y channel conversion: 0 : OFF 1 : ON
5	Z1CONV	0	Enables Z1 channel conversion: 0 : OFF 1 : ON
4	Z2CONV	0	Enables Z2 channel conversion: 0 : OFF 1 : ON
3	Reserved	0	
2	RXCONV	0	Enables RX channel conversion: 0 : OFF 1 : ON
1	RYCONV	0	Enables RY channel conversion: 0 : OFF 1 : ON
0	Reserved	0	

Table 17 : RegChanMsk (Addr 0x04)

Bits	Variable	Default	Description
7	HAPTMODE	0	Defines the haptics mode/input: 0 : PWM 1 : I2C

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6:5	HAPTTYPEEN	00	Defines the haptics load: 00 : OFF. Haptics block disabled. 01 : LRA 10 : ERM 11 : Reserved
4	HAPTRANGE	0	Defines MIN prescaler value: 0 : 128 1 : 256
3:0	HAPTGAIN	0000	Defines the haptics output gain: 0000 : 1 0001 : ~1.17 0010 : ~1.34 0011 : ~1.51 0100 : ~1.67 0101 : ~1.84 0110 : ~2.01 0111 : ~2.18 1000 : ~2.35 1001 : ~2.52 1010 : ~2.69 1011 : ~2.86 1100 : ~3.03 1101 : ~3.20 1110 : ~3.37 1111 : ~3.53 Exact formula is $1 + \text{Code} * 0.169$

Table 18 : RegHapt0 (Addr 0x05)

Bits	Variable	Default	Description
7:6	Reserved	00	
5:3	HAPTSQUELCH	000	Defines the Haptics squelch, i.e. the range of AmplitudeCode (HAPTAMP or MIN duty cycle equivalent, Cf. §6) which will generate a 0V output (VMOUT): 000 : OFF. No squelch. 001 : $-1 < \text{AmplitudeCode} < +1$ (ie. $\text{AmplitudeCode} = 0$) 010 : $-2 < \text{AmplitudeCode} < +2$ 011 : $-4 < \text{AmplitudeCode} < +4$ 100 : $-8 < \text{AmplitudeCode} < +8$ 101 : $-16 < \text{AmplitudeCode} < +16$ 110 : $-32 < \text{AmplitudeCode} < +32$ 111 : $-64 < \text{AmplitudeCode} < +64$
2	TEMPWRNIRQEDG	0	Enables TempWrnlrq to be generated when the chip temperature gets below the alarm threshold : 0 : OFF. TempWrnlrq generated only when the chip temperature gets above the alarm threshold. 1 : ON. TempWrnlrq generated both when the chip temperature gets above and below the alarm threshold.
1	TEMPALRMIRQEDG	0	Enables TempAlrmIrq to be generated when the chip temperature gets below the alarm threshold : 0 : OFF. TempAlrmIrq generated only when the chip temperature gets above the alarm threshold. 1 : ON. TempAlrmIrq generated both when the chip temperature gets above and below the alarm threshold.
0	TEMPALWAYSON	0	Enables the temperature monitoring even when no operation (touch, proximity, haptics) is enabled: 0 : OFF 1 : ON

Table 19 : RegHapt1 (Addr 0x06)

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Bits	Variable	Default	Description
7:0	HAPTAMP	0x00	Defines the haptics output polarity and level in I2C mode i.e. AmplitudeCode (Cf. §6) : 0xFF : +127 (Max positive) ... 0x81 : +1 0x80 : +0 0x00 : -0 0x01 : -1 ... 0x7F : -127 (Max negative) HAPTAMP[7] gives the sign of AmplitudeCode (1=>+;0=>-) while HAPTAMP[6:0] give its magnitude.

Table 20 : RegHapt2 (Addr 0x07)

Bits	Variable	Default	Description
7:5	HAPTBW	100	Defines the haptics low-pass filter cut off frequency (Hz): 000 : OFF. No filtering. 001 : ~210 * SamplingFreq / 100 010 : ~280 * SamplingFreq / 100 011 : ~425 * SamplingFreq / 100 100 : ~565 * SamplingFreq / 100 101 : ~700 * SamplingFreq / 100 110 : ~850 * SamplingFreq / 100 111 : ~980 * SamplingFreq / 100 SamplingFreq is VMOUT_Freq in LRA mode and MIN_Freq (PWM) or FOSCL (I2C) in ERM mode (Cf. §6)
4	HAPTHZ	0	Sets MOUTP and MOUTN to high impedance (HZ): 0 : Normal 1 : HZ
3	HAPTSHORTPROT	0	Disables short-circuit protection: 0 : ON . A short-circuit event will automatically stop haptics operation. 1 : OFF. A short-circuit event will not stop haptics operation. In both cases HAPTSHORTSTAT is still updated (and hence an interrupt can still be generated if needed)
2:0	HAPTTIMERMSB	000	Defines the haptics timer overflow value used to generate the LRA's 128 or 256 multiple frequency from MIN.

Table 21 : RegHapt3 (Addr 0x08)

Bits	Variable	Default	Description
7:0	HAPTTIMERLSB	0x00	Defines the haptics timer overflow value used to generate the LRA's 128 or 256 multiple frequency from MIN. HAPTTIMER[9:0] values below 8 (ie 0-7) are reserved.

Table 22 : RegHapt4 (Addr 0x09)

Bits	Variable	Default	Description
7:0	Reserved	0x00	

Table 23 : RegHapt5 (Addr 0x0A)

Bits	Variable	Default	Description
7	PROXRRAWFILTSEL	0	Defines the proximity raw filtering range for PROXRRAWFILT : 0 : Fast 1 : Slow
6	PROXIRQSEL	0	Defines the function of bits 5 of RegIrqMsk and RegIrqSrc. 0 : ProxFar 1 : ProxConvDone



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5:4	PROXHYST	00	Defines the proximity detection hysteresis : 00 : OFF 01 : 32 10 : 128 11 : 512
3:0	PROXSCANPERIOD	0000	Defines the proximity scan period : 0000 : OFF. Proximity sensing disabled 0001 : 1 / TOUCHRATE (Cf. RegTouch0) 0010 : 2 / TOUCHRATE 0011 : 4 / TOUCHRATE 0100 : 8 / TOUCHRATE 0101 : 16 / TOUCHRATE 0110 : 32 / TOUCHRATE 0111 : 64 / TOUCHRATE 1000 : 128 / TOUCHRATE 1001 : 256 / TOUCHRATE 1010 : 512 / TOUCHRATE 1011 : 1024 / TOUCHRATE 1100 : 2048 / TOUCHRATE 1101 : 4096 / TOUCHRATE 1110 : 8192 / TOUCHRATE 1111 : 16384 / TOUCHRATE

Table 24 : RegProx0 (Addr 0x0B)

Bits	Variable	Default	Description
7:0	PROXTHRESH	0x00	Defines the proximity detection threshold (for PROXSTAT update). Threshold = 16 x register value

Table 25 : RegProx1 (Addr 0x0C)

Bits	Variable	Default	Description
7:6	PROXCLOSEDEB	00	Defines the "Close" debounce (for PROXSTAT update): 00 : OFF 01 : 2 samples 10 : 4 samples 11 : 8 samples
5:4	PROXFARDEB	00	Defines the "Far" debounce (for PROXSTAT update): 00 : OFF 01 : 2 samples 10 : 4 samples 11 : 8 samples
3:0	PROXCOMPPRD	0000	Defines the periodic compensation : 0 : OFF Else : register value x 128 samples

Table 26 : RegProx2 (Addr 0x0D)

Bits	Variable	Default	Description
7:0	PROXSTUCK	0x00	Defines the stuck at timeout (ie max "Close" time before a compensation is automatically requested) : 0 : OFF Else : register value x 16 samples

Table 27 : RegProx3 (Addr 0x0E)

Bits	Variable	Default	Description
7:0	PROXAVGPOSTHRESH	0x00	Defines the average positive threshold (for compensation). Threshold = 8 x register value

Table 28 : RegProx4 (Addr 0x0F)

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Bits	Variable	Default	Description
7:5	PROXAVGPOSDEB	000	Defines the average positive debounce (for compensation) : 000 : OFF 001 : 2 samples 010 : 4 samples 011 : 8 samples 100 : 16 samples 101 : 32 samples 110 : 64 samples 111 : 128 samples
4:2	PROXAVGPOSFILT	000	Defines the average positive filter coefficient : 000 : 0 (ie filtering OFF) 001 : 1 – 1/2 010 : 1 – 1/4 011 : 1 – 1/8 100 : 1 – 1/16 101 : 1 – 1/32 110 : 1 – 1/64 111 : 1 – 1/128
1:0	PROXRAWFILT	00	Defines the raw filter coefficient. If PROXRAWFILTSEL = 0 : 00 : 0 (ie filtering OFF) 01 : 1 – 1/2 10 : 1 – 1/4 11 : 1 – 1/8 If PROXRAWFILTSEL = 1 : 00 : 1 – 1/16 01 : 1 – 1/32 10 : 1 – 1/64 11 : 1 – 1/128

Table 29 : RegProx5 (Addr 0x10)

Bits	Variable	Default	Description
7:0	PROXAVGNEGTHRESH	0x00	Defines the average negative threshold (for compensation). Threshold = – 8 x register value

Table 30 : RegProx6 (Addr 0x11)

Bits	Variable	Default	Description
7:5	PROXAVGNEGDEB	000	Defines the average negative debounce (for compensation) : 000 : OFF 001 : 2 samples 010 : 4 samples 011 : 8 samples 100 : 16 samples 101 : 32 samples 110 : 64 samples 111 : 128 samples
4:2	PROXAVGNEGFILT	000	Defines the average negative filter coefficient : 000 : 0 (i.e. filtering OFF) 001 : 1 – 1/2 010 : 1 – 1/4 011 : 1 – 1/8 100 : 1 – 1/16 101 : 1 – 1/32 110 : 1 – 1/64 111 : 1 – 1/128
1	PROXHIGHIGHIM	0	Enables high noise immunity mode : 0 : OFF 1 : ON, at the expense of higher power consumption.
0	Reserved	0	

Table 31 : RegProx7 (Addr 0x12)



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Bits	Variable	Default	Description
7:4	Reserved	0000	
3:0	PROXRAWMSB	0000	Provides the proximity raw information for monitoring purposes. Signed, 2's complement format. Read-only (using PROXCONVDONE), do not write.

Table 32 : RegProx8 (Addr 0x13)

Bits	Variable	Default	Description
7:0	PROXRAWLSB	0x00	Provides the proximity raw information for monitoring purposes. Signed, 2's complement format. Read-only (using PROXCONVDONE), do not write.

Table 33 : RegProx9 (Addr 0x14)

Bits	Variable	Default	Description
7:4	Reserved	0000	
3:0	PROXUSEFULMSB	0000	Provides the proximity information for monitoring purposes. Signed, 2's complement format. Read-only (using PROXCONVDONE), do not write.

Table 34 : RegProx10 (Addr 0x15)

Bits	Variable	Default	Description
7:0	PROXUSEFULLSB	0x00	Provides the proximity information for monitoring purposes. Signed, 2's complement format. Read-only (using PROXCONVDONE), do not write.

Table 35 : RegProx11 (Addr 0x16)

Bits	Variable	Default	Description
7:4	Reserved	0000	
3:0	PROXAVGMSB	0000	Provides the proximity average information for monitoring purposes. Signed, 2's complement format. Read-only (using PROXCONVDONE), do not write.

Table 36 : RegProx12 (Addr 0x17)

Bits	Variable	Default	Description
7:0	PROXAVGLSB	0x00	Provides the proximity average information for monitoring purposes. Signed, 2's complement format. Read-only (using PROXCONVDONE), do not write.

Table 37 : RegProx13 (Addr 0x18)

Bits	Variable	Default	Description
7:5	Reserved	0000	
4:0	PROXDIFFMSB	0000	Provides the proximity differential information for monitoring purposes. Signed, 2's complement format. Read-only (using PROXCONVDONE), do not write.

Table 38 : RegProx14 (Addr 0x19)

Bits	Variable	Default	Description
7:0	PROXDIFFLSB	0x00	Provides the proximity differential information for monitoring purposes. Signed, 2's complement format. Read-only (using PROXCONVDONE), do not write.

Table 39 : RegProx15 (Addr 0x1A)

Bits	Variable	Default	Description
7:0	PROXOFFSETMSB	0x00	Provides the proximity compensation offset information for monitoring purposes. Read-only (using PROXCONVDONE), do not write.

Table 40 : RegProx16 (Addr 0x1B)



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Bits	Variable	Default	Description
7:0	PROXOFFSETLSB	0x00	Provides the proximity compensation offset information for monitoring purposes. Read-only (using PROXCONVDONE), do not write.

Table 41 : RegProx17 (Addr 0x1C)

Bits	Variable	Default	Description
7	Reserved	0	
6:4	PROXSENSITIVITY	000	Defines the sensitivity : 000 : 0 (Min) 001 : 1 010 : 2 011 : 3 100 : 4 101 : 5 110 : 6 111 : 7 (Max)
3:1	PROXFREQ	000	Defines the operating frequency : 010 : 64 kHz 011 : 90 kHz 100 : 112 kHz 101 : 150 kHz (recommended) Else : Reserved
0	Reserved	0	

Table 42 : RegProx18 (Addr 0x1D)

Bits	Variable	Default	Description
7:4	PROXSENSORCON	0000	Defines the proximity sensor connection, Cf. §5.1 : 0000 : None 0001 : AUX1/WIPER (5-wire TS) 0010 : AUX2 (external) 1000 : X (standard 4-wire TS) 1001 : Y (inverted 4-wire TS) Else : Reserved
3:0	PROXSHIELDCON	0000	Defines the proximity shield connection, Cf. §5.1 : 0000 : None 0011 : AUX3 (external) 1000 : X (inverted 4-wire TS) 1001 : Y (standard 4-wire TS or 5-wire TS) Else : Reserved

Table 43 : RegProx19 (Addr 0x1E)

Bits	Variable	Default	Description
7:6	Reserved	00	
5:3	PROXBOOST	000	Enables proximity boost mode (higher sensitivity) : 100 : ON 110 : OFF (recommended; compulsory when sensor is TS) Else : Reserved
2:0	Reserved	000	Must be set to 100.

Table 44 : RegProx20 (Addr 0x1F)

Bits	Variable	Default	Description
7:0	Reserved	0x01	Must be set to 0x81.

Table 45 : RegProx21 (Addr 0x20)

Bits	Variable	Default	Description
7:0	Reserved	0x00	

Table 46 : RegProx22 (Addr 0x21)



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Bits	Variable	Default	Description
7	HAPTSHORTIRQEN	0	Enables the HaptShort interrupt. 0 : OFF 1 : ON
6	PROXCLOSEIRQEN	0	Enables the ProxClose interrupt. 0 : OFF 1 : ON
5	PROXFARIRQEN/ PROXCONVDONEIRQEN	0	Enables the ProxFar/ProxConvDone interrupt. Cf RegProx0[6] 0 : OFF 1 : ON
4	PROXCOMPDONEIRQEN	0	Enables the ProxCompDone interrupt. 0 : OFF 1 : ON
3	PENTOUCHIRQEN/ TOUCHCONVDONEIRQEN	1	Enables the PenTouch/TouchConvDone interrupt 0 : OFF 1 : ON
2	PENRELEASEIRQEN	0	Enables the PenRelease interrupt. 0 : OFF 1 : ON
1	TEMPWARNINGIRQEN	0	Enables the TempWarning interrupt. 0 : OFF 1 : ON
0	TEMPALARMIRQEN	0	Enables the TempAlarm interrupt. 0 : OFF 1 : ON

Table 47 : RegIrqMsk (Addr 0x22)

Bits	Variable	Default	Description
7	HAPTSHORTIRQ	0	Gives the HaptShort interrupt source status. (ie HAPTSHORTSTAT rising edge)
6	PROXCLOSEIRQ	0	Gives the ProxClose interrupt source status. (ie PROXSTAT rising edge)
5	PROXFARIRQ/ PROXCONVDONEIRQ	0	Gives the ProxFar (ie PROXSTAT falling edge), or ProxConvDone (ie CONVSTAT falling edge after proximity conversion) interrupt status depending on PROXIRQSEL .
4	PROXCOMPDONEIRQ	0	Gives the ProxCompDone interrupt source status. (ie PROXCOMPSTAT falling edge)
3	PENTOUCHIRQ/ TOUCHCONVDONEIRQ	0	Gives the PenTouch/TouchConvDone interrupt source status. (ie in PENDET mode -> PENSTAT rising edge, else -> CONVSTAT falling edge after touch conversion)
2	PENRELEASEIRQ	0	Gives the PenRelease interrupt source status. (ie PENSTAT falling edge)
1	TEMPWARNINGIRQ	0	Gives the TempWarning interrupt source status. (ie TEMPWARNINGSTAT rising/falling edge depending on TEMPWRNIRQEDG)
0	TEMPALARMIRQ	0	Gives the TempAlarm interrupt source status. (ie TEMPALARMSTAT rising/falling edge depending on TEMPALRMIRQEDG)

Table 48 : RegIrqSrc (Addr 0x23)

Bits	Variable	Default	Description
7	HAPTSHORTSTAT	0	Gives the haptics short-circuit instantaneous status : 0 : No short circuit is currently present 1 : A short circuit is currently present
6	RESETSTAT	0	Gives the reset latched status : 0 : No reset occurred 1 : A reset occurred This bit is cleared when RegStat is read.



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5	PROXSTAT	0	<p>Gives the proximity instantaneous status: 0 : Far (or proximity sensing disabled) 1 : Close</p> <p>PROXSTAT (and PROXAVG) is automatically frozen to its current value if pen is down (whether TS or AUXi is the sensor) PROXSTAT is NOT frozen while haptics is running, if needed host can turn proximity sensing ON/OFF via PROXSCANPERIOD.</p>
4	PROXCOMPSTAT	0	<p>When read, this bit indicates gives the compensation instantaneous status : 0 : No compensation is currently pending 1 : A compensation is currently pending execution and/or completion</p> <p>When set to '1', triggers a compensation for next scan period.</p>
3	CONVSTAT	0	<p>Gives touch/proximity conversion instantaneous status : 0 : No touch or proximity conversion is currently running 1 : A touch or proximity conversion is currently running</p>
2	PENSTAT	0	<p>Gives the pen instantaneous status : 0 : Released/Up 1 : Touching/Down</p>
1	TEMPWARNINGSTAT	0	<p>Gives the temperature warning instantaneous status : 0 : Temperature is below warning threshold 1 : Temperature is above warning threshold</p>
0	TEMPALARMSTAT	0	<p>Gives the temperature alarm instantaneous status : 0 : Temperature is below alarm threshold 1 : Temperature is above alarm threshold</p>

Table 49 : RegStat (Addr 0x24)

Bits	Variable	Default	Description
7	Reserved	0	
6	AUX1DIGOUTEN	0	Enables the digital output capability of AUX1 0 : OFF 1 : ON, Cf. AUX1DIGOUT. Bit is ignored if TSTYPE = 1 or PROXSENSORCON = 0001
5	AUX2DIGOUTEN	0	Enables the digital output capability of AUX2 0 : OFF 1 : ON, Cf. AUX2DIGOUT. Bit is ignored if PROXSENSORCON = 0010
4	AUX3DIGOUTEN	0	Enables the digital output capability of AUX3 0 : OFF 1 : ON, Cf. AUX3DIGOUT. Bit is ignored if TSTYPE = 1 or PROXSHIELDCON = 0011
3:0	AUX1DIGOUT	0000	Defines the digital signal to output on AUX1 : 0000 : RegLrqSrc(0) 1000 : RegStat(0) 0001 : RegLrqSrc(1) 1001 : RegStat(1) 0010 : RegLrqSrc(2) 1010 : RegStat(2) 0011 : RegLrqSrc(3) 1011 : RegStat(3) 0100 : RegLrqSrc(4) 1100 : RegStat(4) 0101 : RegLrqSrc(5) 1101 : RegStat(5) 0110 : RegLrqSrc(6) 1110 : RegStat(6) 0111 : RegLrqSrc(7) 1111 : RegStat(7)

Table 50 : RegAux0 (Addr 0x25)



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Bits	Variable	Default	Description
7:4	AUX2DIGOUT	0000	Defines the digital signal to output on AUX2 : 0000 : RegIrqSrc(0) 1000 : RegStat(0) 0001 : RegIrqSrc(1) 1001 : RegStat(1) 0010 : RegIrqSrc(2) 1010 : RegStat(2) 0011 : RegIrqSrc(3) 1011 : RegStat(3) 0100 : RegIrqSrc(4) 1100 : RegStat(4) 0101 : RegIrqSrc(5) 1101 : RegStat(5) 0110 : RegIrqSrc(6) 1110 : RegStat(6) 0111 : RegIrqSrc(7) 1111 : RegStat(7)
3:0	AUX3DIGOUT	0000	Defines the digital signal to output on AUX3 : 0000 : RegIrqSrc(0) 1000 : RegStat(0) 0001 : RegIrqSrc(1) 1001 : RegStat(1) 0010 : RegIrqSrc(2) 1010 : RegStat(2) 0011 : RegIrqSrc(3) 1011 : RegStat(3) 0100 : RegIrqSrc(4) 1100 : RegStat(4) 0101 : RegIrqSrc(5) 1101 : RegStat(5) 0110 : RegIrqSrc(6) 1110 : RegStat(6) 0111 : RegIrqSrc(7) 1111 : RegStat(7)

Table 51 : RegAux1 (Addr 0x26)

Bits	Variable	Default	Description
7:0	SOFTRESET	0x00	Writing 0xDE will reset the chip and all registers to their default values.

Table 52 : RegReset (Addr 0x3F)

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13 APPLICATION INFORMATION

13.1 Typical Application Circuit

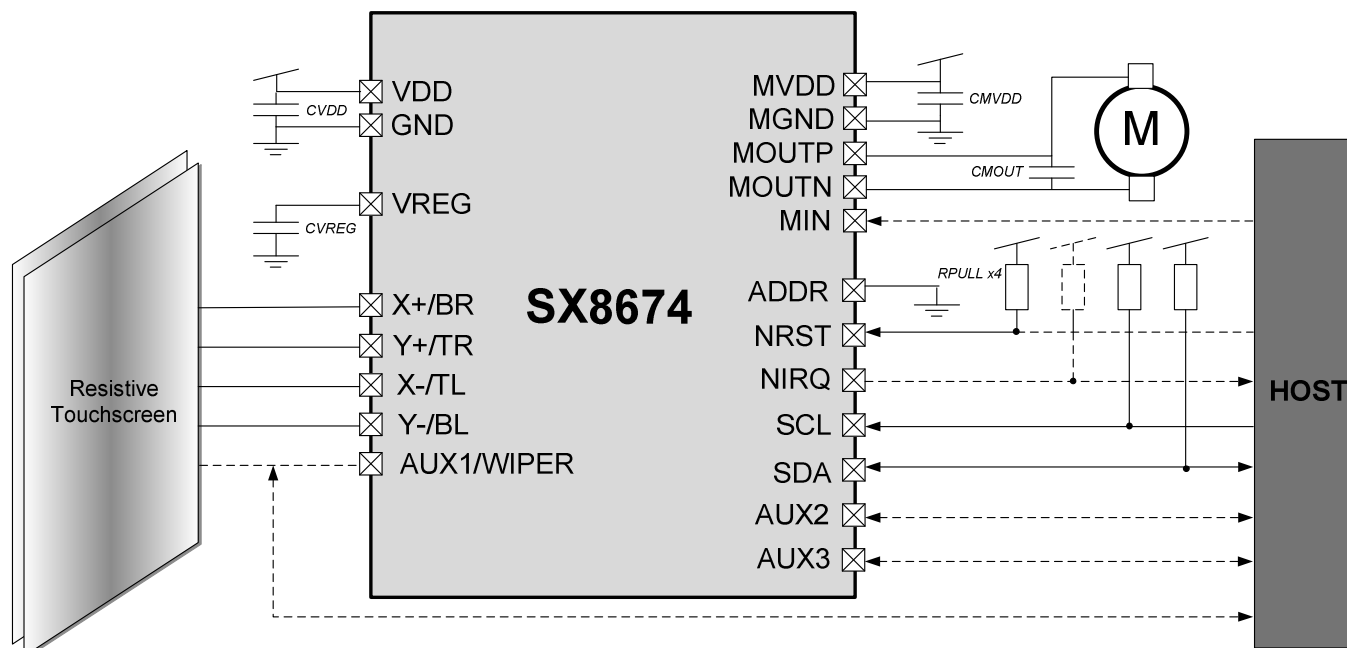


Figure 58 – Typical Application Circuit

13.2 External Components Recommended Values

Symbol	Description	Note	Min	Typ.	Max	Unit
CVDD	Main supply decoupling capacitor		-	1	-	uF
CMVDD	Motor supply decoupling capacitor		-	10	-	uF
CVREG	Regulator decoupling capacitor	+/- 20%, ESR<1Ω	-	100	-	nF
RPULL	Host interface pull-ups	+/- 50%	-	10	-	kΩ
CTB	Proximity sensor-to-shield capacitance	-	-	<0.7	1.5	nF
RXY	Proximity sensor serial resistor	-	-	<1	1.5	kΩ
RMOT	Motor resistance	-	7.5	-	-	Ω
CMOUT	Motor output capacitor	-	-	1	-	uF

Table 53 : External Components Recommended Values

13.3 Multitouch Gestures

13.3.1 Pinch/Stretch

A simple thumb and forefinger “pinch” movement enables a user to enlarge objects onscreen (moving fingers away from each other) or make them smaller (move them towards each other). This intuitive zooming function replaces the standard point-and-click functionality of a mouse and provides far greater accuracy to the user.



Figure 59 – Pinch/Stretch Multitouch Gestures

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ADVANCED COMMUNICATIONS & SENSING**13.3.2 Rotate**

Objects are rotated onscreen by making simple clockwise (right) or counterclockwise (left) movements with the anchored thumb and forefinger. This multi-touch function enables swift and accurate positioning of objects without needing to point and click repeatedly on a rotate left-right function button in order to achieve the desired effect.

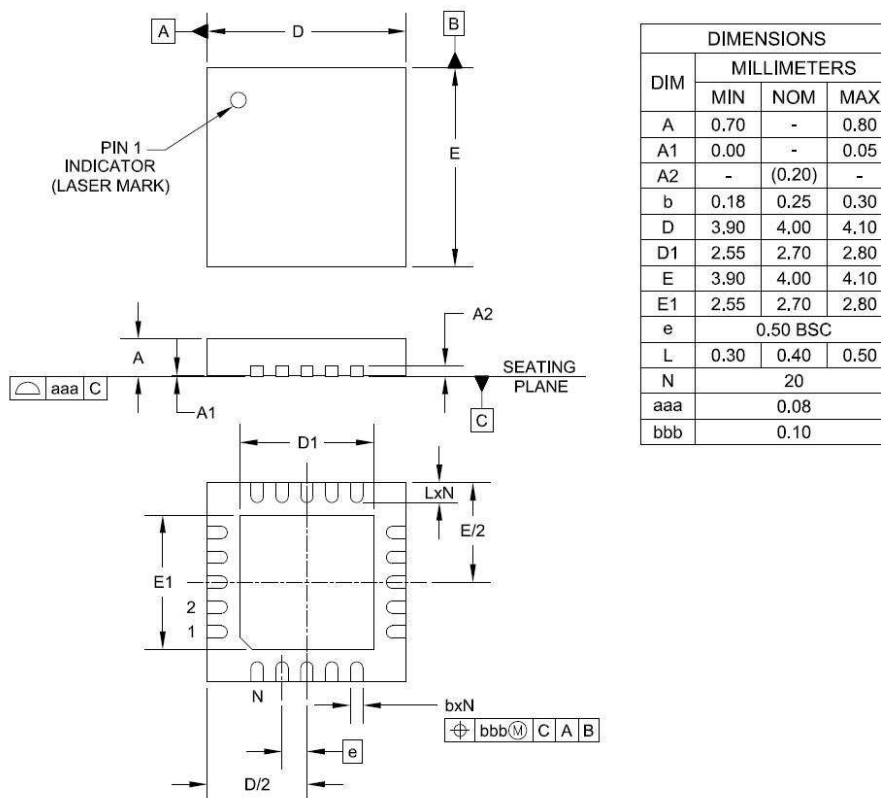


Figure 60 – Rotate Multitouch Gestures

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14 PACKAGING INFORMATION

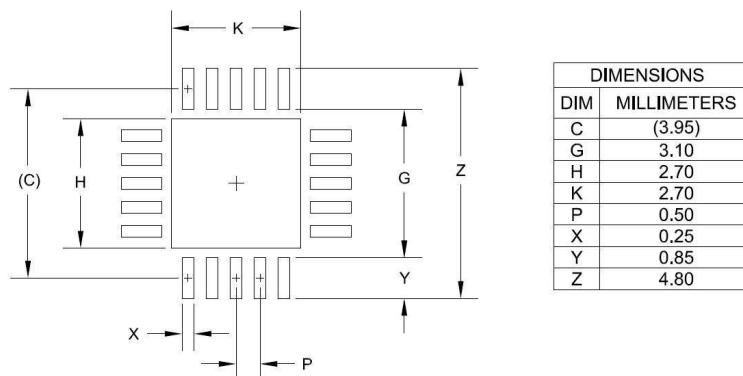
14.1 QFN Package



NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

Figure 61 - Outline Drawing - QFN



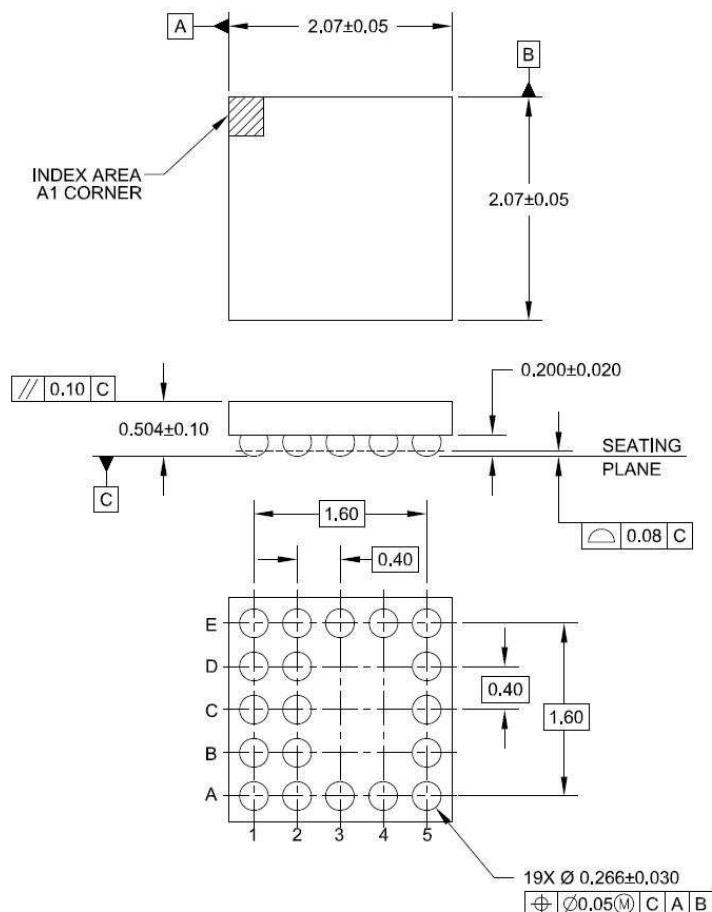
NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.
3. THERMAL VIAS IN THE LAND PATTERN OF THE EXPOSED PAD SHALL BE CONNECTED TO A SYSTEM GROUND PLANE. FAILURE TO DO SO MAY COMPROMISE THE THERMAL AND/OR FUNCTIONAL PERFORMANCE OF THE DEVICE.

Figure 62 - Land Pattern - QFN

ADVANCED COMMUNICATIONS & SENSING

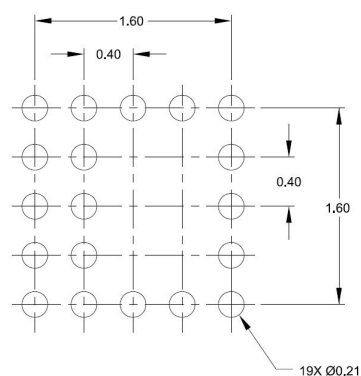
14.2 CSP Package



NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS

Figure 63 - Outline Drawing - CSP



NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

Figure 64 - Land Pattern - CSP

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